

WELCOME TO THE 27th
CHINA INTERNATIONAL OPTOELECTRONIC EXPOSITION



1st Edition on July 14, 2026

PRESHOW GUIDE

SEPTEMBER 9 – 11, 2026

SHENZHEN, CHINA

SHENZHEN WORLD EXHIBITION & CONVENTION CENTER

8 EXPOS IN ONE SHOW



INFORMATION AND
COMMUNICATION
EXPO



PRECISION OPTICS EXPO
& CAMERA EXPO



LASERS TECHNOLOGY &
INTELLIGENT MANUFACTURING
EXPO



INFRARED
APPLICATIONS
EXPO



INTELLIGENT
SENSING
EXPO



DISPLAY
TECHNOLOGY
EXPO



AR&VR
EXPO



PHOTONICS
INNOVATION
EXPO

EXHIBITION AREA: **260,000 sqm**

EXHIBITORS: **4,000+**

VISITORS: **150,000+**

CONFERENCES: **90+**

Co-located Events



IIICIE

INTERNATIONAL
INTEGRATED CIRCUIT
INNOVATION EXPO

elexcon



GET YOUR FREE PASS

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GET A FREE PASS

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Visitor Registration



About CIOE

The 27th China International Optoelectronic Exposition (CIOE 2026) will take place from September 9–11, 2026, at the Shenzhen World Exhibition and Convention Center. As a premier event covering the entire optoelectronics industry chain, CIOE gathers over 4,000 leading exhibitors from 30+ countries and regions. Co-located with eight expos covering sectors such as **information and communication, precision optics, laser, infrared, intelligent sensing, display, AR & VR**, etc. CIOE serves as a one-stop efficient procurement platform for industry professionals to source materials, components, equipment, and solutions. It is also an ideal trade hub for precise business matching, networking, and discovering the latest industry trends.

Highlights of CIOE 2026

1. Long-established Optoelectronics Event & Industry Benchmark

Founded in 1999 with 26 years' experience, CIOE boasts remarkable influence within the global optoelectronics community.

2. Complete Value Chain Coverage with Cutting-Edge Innovation Focus

Leading enterprises gather together across the entire optoelectronics industrial chain. Over a thousand brands launch new products, while featured zones spotlight the latest industry trends.

3. Concurrent Conference Bridging Industry, Academia and Research

Premier conference programs feature academicians from the Chinese Academy of Sciences and Chinese Academy of Engineering, distinguished experts and top management from leading companies, covering industry trend analysis, academic discussions, international exchanges and practical applications.

4. Global Professional Visitors Enabling Precision Networking

Visitors from upstream and downstream industrial players, application sectors and research institutes, enables precise connections across industry, technology and scientific research.

5. Year-Round Engagement: 360-Day Service Model

Beyond the three-day exhibition, we deliver continuous support via online & offline pre-show activities, business matchmaking and technical exchanges all year round.

6. Three Co-located Exhibitions Creating an Integrated Industrial Ecosystem

Co-located with IICIE (International Integrated Circuit Innovation Expo) and ellexcon (Shenzhen International Electronics & Embedded Systems Expo), the platform creates an exhibition ecosystem spanning upstream "chips & core components" to downstream "terminals and application scenarios".



Four Industry Trends

Industry Trend 1: AI Optical Interconnect – The Foundational Infrastructure for the Computing Era

Driven by the explosive growth of AI computing power, traditional copper interconnects have revealed three major bottlenecks: bandwidth limitations, severe heat generation under heavy loads, and short transmission distance, making them incapable of supporting supercomputing clusters with tens of thousands of GPUs. AI optical interconnects have emerged as the core infrastructure for supercomputing centers, AI servers and chip cabinets.

A comprehensive one-stop sourcing platform showcasing cutting-edge solutions: **1.6T high-speed pluggable optical modules, next-generation computing architecture CPO/NPO co-packaged optics, high-performance silicon photonic ICs, OCS all-optical switches, and MPO high-speed fiber connectors for computing networking**, covering the full spectrum of intelligent computing interconnect chains.

Industry Trend 2: AI Reshapes Intelligent Sensing & Imaging – From "Seeing" to "Understanding"

Today, AI algorithms serve as the brain of optoelectronic systems, forming an integrated closed loop of data collection, edge computing and intelligent recognition, which enables exponential expansion of application scenarios.

Immersive real-world application scenarios showcased at the exhibition:

- **Intelligent Optics:** AI computational imaging delivers real-time optimization for low-light performance, image stabilization and picture quality, making smartphones, surveillance cameras and medical endoscopes increasingly intelligent.
- **Intelligent Sensing:** Long-distance, high-precision environmental perception with millimeter-level obstacle recognition, empowering autonomous driving, robotics and smart security.
- **Infrared Imaging:** Embedded with AI early fault warning models, it drastically boosts efficiency for industrial temperature measurement, power grid inspection and fire risk prediction.
- **Consumer XR:** Pancake VR + AI simulated optical paths and metasurface optics ushers in a new era of ultra-lightweight devices.



Four Industry Trends

Industry Trend 3: AI Upgrades Intelligent Manufacturing – From Precision to Ultra-Smart Production

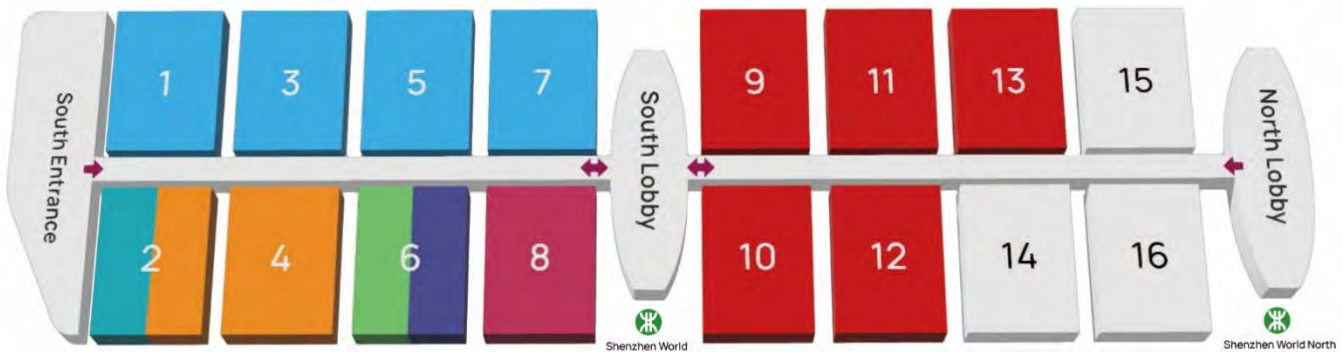
AI integrates the full industrial chain of **optical processing, laser equipment, coating and optical inspection**. Automatic parameter calibration drastically boosts machining accuracy; intelligent beam and power control reduces reject rates and predicts equipment downtime; AI-optimized coating processes minimize film layer defects and increase production yields; machine vision inspection automatically identifies micron-level flaws with real-time closed-loop corrections on production lines. This transformation propels precision machining, semiconductors, optical chips and new energy industries into a brand-new development phase.

Industry Trend 4: Three Co-located Exhibitions, Building a Photonics-Semiconductor-Electronics Ecosystem

Co-hosted with the International Integrated Circuit Innovation Expo (IICIE 2026) and Shenzhen International Electronics & Embedded Systems Expo (elexcon 2026), the three concurrent exhibitions form a massive industrial event spanning 320,000 square meters. Focusing on the entire AI computing industrial chain, it builds an integrated industrial ecosystem covering **photonics, storage, chips and electronics**.

It links up the comprehensive **AI computing power industrial chain**, ranging from AI optical interconnection transmission, high-speed data storage and power support to core computing chips and semiconductor manufacturing processes. Breaking the industrial limitations of single exhibitions, it accelerates the implementation of domestic AI computing infrastructure.

Fairground Map



1 Precision Optics Expo & Camera Expo

Camera Technology and Application Hall

- Optical Lens
- Camera Module

3 Precision Optics Expo & Camera Expo

Camera Technology and Application Hall

- Test and Measurement
- Optical Injection / Modeling Aspherical Technology
- Sapphire Processing and Application
- Machine Vision / Industrial Automation

5 Precision Optics Expo & Camera Expo

Precision Optics Processing Hall

- Ultra-Precision Processing
- Optical Component
- Optical Material
- Optical Processing Equipment

7 Precision Optics Expo & Camera Expo

Optical Vacuum Coating Hall

- Optical Coating Material
- Optical Coating Component
- Optical Coating Equipment

2 Lasers Technology & Intelligent Manufacturing Expo Display Technology Expo AR&VR Expo

- Laser Equipment / Laser Welding
- Intelligent Equipment and Automation
- Mini/Micro LED Microdisplay
- Automotive Display
- AR/VR Product and Application

4 Lasers Technology & Intelligent Manufacturing Expo

- Laser Material and Component
- Laser Subassembly and Auxiliary System
- Lasers
- Laser Spectroscopy and Testing & Measurement
- Laser Medical Aesthetics

6 Intelligent Sensing Expo Photonics Innovation Expo

- 3D Vision and Imaging
- LiDAR & Quantum Sensing
- Industrial Sensor and Testing & Inspection System
- Embodied Robot
- Scientific Institute / University
- High-tech and Innovative Enterprise

8 Infrared Applications Expo

- Infrared Thermal Imaging Technology and Application
- Night Vision Device and Application
- Imaging Instrument Inspection System and Equipment
- Infrared Temperature Measurement and Material
- Ultraviolet Technology and Application

9 Information and Communication Expo

Optical Connection Technology Hall

- Optical Device
- Optical Fiber Cable / Wire and Cable
- FTTX Next-Generation Optical Network
- Optical Fiber Fusion Splicing
- Data Center

10 Information and Communication Expo

Semiconductor and Intelligent Optical Communication Equipment Hall

- Test and Measurement / Instrument
- Packaging Equipment
- Production and Manufacturing

11 Information and Communication Expo

Communication Device and Module Hall

- Chip Design
- Compound Semiconductor / Optical Chip / Component
- Subassembly / Module
- Satellite / Space Communication
- Automotive Optical Communication

12 Information and Communication Expo

Communication Device and Module Hall

- Chip Design
- Compound Semiconductor / Optical Chip / Component
- Subassembly / Module
- Information Transmission Equipment
- Automotive Optical Communication

13 Information and Communication Expo

Communication Device and Module Hall

- Chip Design
- Compound Semiconductor / Optical Chip / Component
- Subassembly / Module
- Automotive Optical Communication

Co-located Events

Hall 14-16



International Integrated Circuit Innovation Expo (IIICIE 2026)

Hall 16



Shenzhen International Electronics & Embedded Expo (elexcon 2026)



Featured Zones

➤ Automotive Optical Communication Zone – Hall 13

Automotive optical communication is emerging as a cornerstone technology for next-generation intelligent automotive architectures, driven by its exceptional bandwidth capacity, minimal latency, robust electromagnetic immunity, and reduced weight. This technology provides essential infrastructure for advanced autonomous driving systems.



Exhibit Profile

Automotive Network, Switch, Chip, Lasers, LiDAR, Module, Connector, Transmission Equipment, Inspection and Testing Instrument, Device, Accessories, etc.

➤ Automotive Display Zone – Hall 2



The vehicle cockpit is rapidly transforming into "the second intelligent display terminal." From center consoles and instrument clusters to HUD/AR HUD and multi screen interactions, automotive displays are undergoing a new wave of technological upgrade. The CIOE - Display Technology Expo, in partnership with OE Auto, will launch the Automotive Display Zone, featuring **intelligent cockpit displays, Mini/Micro LED, automotive optics, automotive grade materials, modules, and manufacturing & testing solutions** – presenting cutting edge products and innovative solutions across the automotive display supply chain.

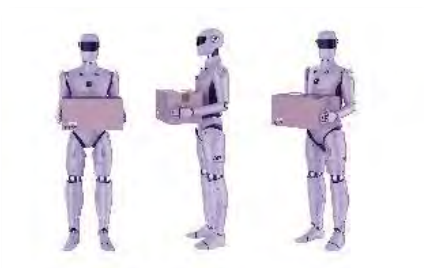
➤ XR Glasses Teardown Zone – Hall 2

This zone brings together a **full range of XR devices – including AI glasses, AR glasses, and MR terminals – in non-destructive, fully deconstructed samples** that reveal every structural layer from exterior frames to micro components. It creates a rare, open access platform for hardware inspection and industry insight.





Featured Zones



➤ Embodied Robot Zone - Hall 6

Co-organized with ZBO in Hall 6, this zone focuses on two core technological innovations – intelligent control and environmental perception – along with the development of underlying data infrastructures. It aims to bridge technology R&D, industrial implementation, and capital enablement, continuously strengthening the core competitiveness of embodied robots in full-scenario applications.

➤ Laser Medical Aesthetics Zone - Hall 4

The Medical Laser & Aesthetic Zone in Hall 4 provides an end-to-end showcase of the medical laser value chain, featuring application areas such as precision surgical cutting, high efficiency tumor ablation, and aesthetic medicine use cases including skin rejuvenation and texture refinement. It is a one stop destination for exploring cutting edge technologies in laser medicine and medical aesthetics.



➤ Laser Welding Zone – Hall 2

Laser welding offers technical advantages including high energy density, high welding speed, minimal heat affected zone, aesthetically pleasing welds, and high joint strength. It is widely applied in key industrial sectors such as automotive manufacturing, aerospace, electronics, new energy, precision machinery, and more, making it a key enabling technology for intelligent manufacturing upgrades. The Laser Welding Zone in Hall 2 showcases the latest equipment and advanced processes in laser welding, providing a professional platform to explore future directions, address core process challenges, and access efficient, reliable solutions.



Featured Zones

➤ Telescope and Astronomical Equipment Zone – Hall 3

Astronomical optical technology is experiencing a breakthrough period of high precision, intelligence, and multi-scenario integration. The pursuit of ultimate observational capabilities by professional researchers and the demand for convenient, intelligent experiences by enthusiasts are jointly pushing the boundaries of industry innovation. This zone highlights innovative achievements and development trends in astronomical telescopes, bird-watching scopes, binoculars, sighting scopes, astronomical imaging cameras, astrophotography solutions, and more.



➤ Optical Injection Molding / Molded Aspheric Zone – Hall 3

Optical injection molding and molded aspheric optics are becoming key drivers in overcoming traditional optical bottlenecks, thanks to their strengths in high-precision forming, efficient high-volume production, and broad design freedom. This zone showcases cutting-edge advances in optical injection molding and molded aspheric technologies, delivering critical enabling capabilities for smartphone imaging, autonomous vehicles, AR/VR, and other fields.

➤ Sapphire Processing & Application Zone – Hall 3

This zone showcases breakthrough developments in sapphire technology that meet extreme requirements for protection, high light transmission, corrosion resistance, and reliability. These innovations are empowering technological upgrades and product innovation in cutting-edge fields including LED, consumer electronics, medical equipment, and aerospace.





Information and Communication Expo

As a highly influential professional exhibition for information and communication technology, **CIOE – Information and Communication Expo** showcases the entire industry chain, including **components, chips, devices, modules, equipment, and solutions**, as well as **semiconductor materials and equipment**. The exhibition comprehensively serves the telecommunications, data center, and emerging markets, and is dedicated to building a professional platform for equipment manufacturers, contractors, operators, internet companies, and industry stakeholders for business matchmaking, international collaboration, and brand visibility.

Hall 9 – Optical Connection Technology

- Optical Device
- Optical Fiber Cable / Wire and Cable
- FTTX Next-Generation Optical Network
- Optical Fiber Fusion Splicing
- Data Center

Hall 10 – Semiconductor and Intelligent Optical Communication Equipment

- Test and Measurement / Instrument
- Packaging Equipment
- Production and Manufacturing Equipment

Hall 11 – Communication Device and Module

- Chip Design
- Compound Semiconductor / Optical Chip / Component
- Subassembly / Module
- Satellite / Space Communication
- Automotive Optical Communication

Hall 12 – Communication Device and Module

- Chip Design
- Compound Semiconductor / Optical Chip / Component
- Subassembly / Module
- Information Transmission Equipment
- Automotive Optical Communication

Hall 13 – Communication Device and Module

- Chip Design
- Compound Semiconductor / Optical Chip / Component
- Subassembly / Module
- Automotive Optical Communication



Optical Communication Chip

PHOGRAIN
BOOTH: 11B33



Multichannel
56GBaud InGaAs
PIN PD Serial chip

Dioo Microcircuits
BOOTH: 11D62



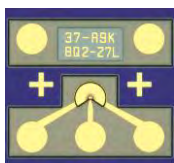
DIO10904

Dogain
BOOTH: 12C35



Optical
Communication Chips

FastPhide
BOOTH: 13A703



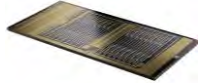
400G/lane Ultra-
High-Speed PD Chip

UX IC
BOOTH: 11C33



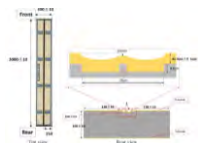
400G/800G/1.6T PAM4
transceiver Solution

Xphor
BOOTH: 13C56



3.2T TRx PIC for
CPO

Shijia Photons
BOOTH: 11B25



500mW 1310nm
CW DFB Laser
Diode Chip

SMART Photonics
BOOTH: 13A95-1



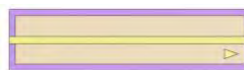
110+ GHz
modulator

QXP Technologies
BOOTH: 11C31



Optical Switch
Chip/Module

EVERBRIGHT
BOOTH:13C51



200mW DFB OPTICAL
COMMUNICATION CHIPS

Credo Technology
BOOTH: 13A25



Silicon Photonics
PICs

Tower Semiconductor
BOOTH: 13A76



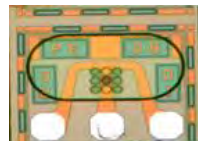
SiPho Technology
Platform

MACOM
BOOTH: 11D31



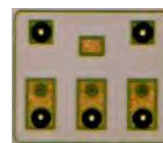
PCIe 6.0 Optical
Transceiver Chipset

Sifotonics
BOOTH: 13A88



200G/Lane PAM4
GeSi PD

Photonteck
BOOTH: 12A13



200G/lane PD
(PD6005-08M3-T)

Guangpu Electronics
BOOTH: 11T52-2



Optical Engine



Optical Communication Module

Accelink
BOOTH: 11B53



6.4T NPO

Pioseed
BOOTH: 13A68



1.6T OSFP224 AEC

QXP Technologies
BOOTH: 11C31



Single Lambda BiDi
Transceiver

Sont Technologies
BOOTH: 12B35



1.6T OSFP 2xDR4

Tri-Light
BOOTH: 13C61



High speed optical
module series

Credo Technology
BOOTH: 13A25



ZeroFlap Optical
Transceivers

CIG
BOOTH: 12A55



1.6T OSFP 2xDR4 /
DR4-2

Source Photonics
BOOTH: 13A66



1.6T DR8/2XFR4
OSFP

Yunvo
Communication
BOOTH: 12D08



Optical Transceiver
Module

Guangpu
Electronics
BOOTH: 11T52-2



Automotive Optical
Communication
Module

RAYCOMM TECH
BOOTH: 13C724



Transceiver Series

Willfar
BOOTH: 11B29



WF-NQ31D-CD0
400Gb/s QSFP112
DR4 Transceiver

Maxlink
Optoelectronics
BOOTH: 13C726



SFP 1.25G 1310nm
20km LC
transceiver

PINTONG
OPTOELECTRONIC
BOOTH: 13A726



100GBASE-LR4 QSFP28
LWDM4 1310nm 10km
Duplex LC

FAST PHOTONICS
BOOTH: 13T52



1.6T DR8 Optical
Transceiver

CREALIGHTS
BOOTH: 12C31



1.6T OSFP224-IHS
2xDR4



Optical Subassembly

SCHOTT
BOOTH: 12A67



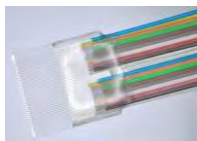
Hermetic packages
for high power laser
diodes - TO9 copper
header

HYC
BOOTH: 11B59



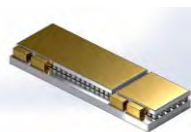
Optical Subassemblies for
800G/1.6T/SiPh Transceivers

Shijia Photons
BOOTH: 11B25



FAU

IceCore
Semiconductor
BOOTH: 13A722



Dual Power Precise
Thermoelectric Modules

Etern
BOOTH: 11C21



MT-FAU
Components

MTC RUGU
COMMUNICATION
BOOTH: 13C55



TOSA

FIBX Optics
BOOTH: 12B707



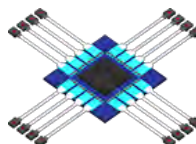
Optical Switch

JNJOPTO
BOOTH: 13C08



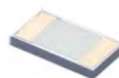
TO18 LED

Advanced Fiber
Resources
BOOTH: 12B55



CPO FAU

Murata (China)
BOOTH: 11D32



Ultra Broadband
Silicon Capacitors

Xinlian
Optoelectronics
BOOTH: 13A702



High-precision
silicon V-groove

sky semiconductor
BOOTH: 11C72



IPD

SUNA
BOOTH: 13A61



Silicon capacitor

Optowide
Technologies
BOOTH: 12C51



MT Fiber Array

Asipin
BOOTH: 11C75



GPON ONU Pigtail
BOSA

Cheerful Micro-Nano
BOOTH: 12C726、12C727



Clens



Optical Communication Device

TFC Optical
Communication
BOOTH: 13A65



HCWDM Filter Block

Fiberhome
Telecommunication
BOOTH: 11A53



FiberHome Polarization-
Maintaining MPO
Connector

O-Net Technologies
Group
BOOTH: 12B51



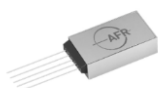
QSFP-DD EDFA

3M China
BOOTH: 11A29



Expanded Beam Optical
Fiber Ferrule

Advanced Fiber
Resources
BOOTH: 12B55



Optical Circulator

Triple-Stone
Technology
BOOTH: 12D91



MCF FIFO

Flyin Group
BOOTH: 9B51



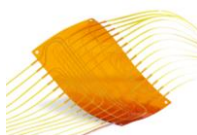
Outdoor waterproof
connector

Dogain
BOOTH: 12C35



Muti-mode Fiber
Coupling Module

T&S
Communications
BOOTH: 9B71



Fiber Optic Flex
Circuit

SENKO Advanced
Components
BOOTH: 9A55



MPC (Metallic PIC
Connector) 36F
Connector

Mixed-Signal
Devices
BOOTH: 11A71



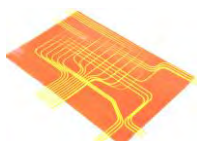
Oscillator

ZZiPho
BOOTH: 13A97



PCIe 5.0 AOC &
Adaptor Card

OPTICAL NETWORK
TELECOM
BOOTH: 9T31



Optical Flex Circuit

Dragonfly
Automation
BOOTH: 9T35



MPO Ferrule
Tungsten Carbide
Fine Pins

XIANGSHENG
COMMUNICATION
BOOTH: 9B107



MPO MT Ferrule:
12-core / 16-core /
24-core / 32-core

Aumiwalker
BOOTH: 10D301



Coaxial Fixed
Attenuator



Optical Communication Data Center Equipment

Fiberhome
BOOTH: 11A53



FiberHome Fengine
51.2T NPO Switch

Triple-Stone
BOOTH: 12D91



512×512 OCS(Optical
Circuit Switch)

ZTT
BOOTH: 11A33



Solid State
Transformer

Bilightech
BOOTH: 12C72



Optical Circuit
Switch

UTStarcom
BOOTH: 12A72



SkyFlux Converged
Packet Transport

Beeplux
Semiconductor
BOOTH: 12C69



Optical Circuit
Switch (OCS)

Glsun
BOOTH: 13C81



Optical Circuit
Switch OCS

Sirivision
BOOTH: 12C56



24*2.5G+2*10G SFP L3
SNMP Managed Switch
with 24Ports PoE

Optical Communication Transmission Equipment

Yingdakang E-TECH
BOOTH: 12C703



wifi7 router

UN Communication
Equipment
BOOTH: 12C71



TG730AX

Asipin
BOOTH: 11C75



4*GE XPON ONU

C-Data
BOOTH: 12B39



6U Chassis XGS-
PON & GPON OLT
FD6700S

PREVAIL
COMMUNICATION
BOOTH: 12C26



WE-1550-YZB-C

ISEELINK
BOOTH: 12C11



OSP3800 CWDM DWDM
Wavelength Division
Multiplexing Equipment

RUID ELE-TECH
BOOTH: 9A92



200G 400G DCI

Sintai
BOOTH: 12A59



OTNS8600-DCI Optical
Transmission Equipment



Optical Fiber Cable / Fiber Sensing

Etern
BOOTH: 11C21



Hollow-core optical
fiber

Sunward
BOOTH: 11D207



High Speed Copper
Cable

rihai Communication
BOOTH: 9C11



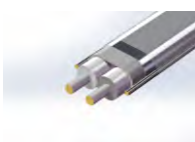
FTTA Drop Cable

Far East
Communication
BOOTH: 9A13



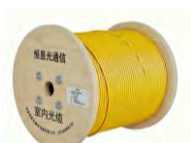
HC_ARF-235-O

Belden Hirschmann
BOOTH: 11D206



224~448Gbps high
speed copper cable

Hengyuguang
BOOTH: 9D77



Indoor Optical Cable

Yangtze Optical
Fibre and Cable
BOOTH: 11B31



Erbium Doped Fibre

Youngsun Com
BOOTH: 9C33



MPO Cable 2~3456
Core

JIAYUDA
BOOTH: 9D162、9D163



MPO High Density
Breakout Fiber Patch Cord

Fiberhome
BOOTH: 11A53



FiberHome VSFF
Connector Fan-out Cable

TAKFLY
COMMUNICATIONS
BOOTH: 9A52



High Speed MTP-LC
Breakout Cable

Weichuang
BOOTH: 9D57



MPO Cable

Wire and Cable Manufacturing Equipment

Minghao
opoelectronics
BOOTH: 10D325



MPO Four-Corner
Pressure Fiber
Polishing Machine

Juhere Photonics
BOOTH: 9D53



Large Diameter
Optical Fiber
Cleaver

BULLS TECHNOLOGY
BOOTH: 10C307、10C308



Bulls-3900 Polishing Machine
+ Quick-Locking Fixtures

YONGCHENG GUANG
ELECTRONICS
BOOTH: 9D27



UV LED Curing
Machine

[>>> View more products](#)



Instrument

Keysight
Technologie
BOOTH: 10B31



FITS-8CH

EXFO
BOOTH: 10B53



BA-1600 - 1.6T Bit
Analyzer

Anritsu
BOOTH: 10B33



BERTWave
MP2110A

Photontek
BOOTH: 12A13



Multi-port
800G/1.6T
Ethernet/OTN
Network Tester

Santec
BOOTH: 10A52



High Performance
Tunable Laser TSL-
580

Direc Precision
Engineering
BOOTH: 10C55



Ultra-Precision
Wafer Inspection
Platform

Dimension Technology
BOOTH: 10A35



1.6T High-Speed
Signal Test Solution

piezosystem jena
BOOTH: 10C631



TRITOR 100 SG

HAROGIC
BOOTH: 10D312



PX Series Spectrum
Analyzers

Ruihong
Communication
BOOTH: 11D86



fiber cleaver

Nantong
SwiPotoniX
BOOTH: 9A71-5



fiber Bragg grating
(FBG) interrogator

Juhere Photonics
Technologies
BOOTH: 9D53



PM Optical Fiber
Fusion Splicer

Teradyne
BOOTH: 10C650、10C651



QCA Digital
Sampling
Oscilloscope

RESOO
BOOTH: 10D712



Programmable
Optical Attenuator

Colibri Technologies
BOOTH: 10D11



COS AOI Machine

Zhiting Technology
BOOTH: 10D22

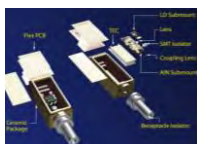


TMC-322G High
Precision Video
Measuring Machine



Semiconductor Materials

Hitachi
BOOTH: 13A87



One stop shop -
Optical device
assembly materials

Sequameta Semiconductor
Materials
BOOTH: 11D99



Anisotropic
Conductive Paste

Pepper Gray
BOOTH: 13C66



AlN Multilayer
Ceramic Substrates

Pepper Gray
BOOTH: 13C66



Glass Substrates

CHANGKE CERAMIC
NEW MATERIAL
BOOTH: 12D722



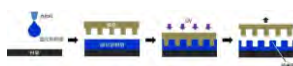
Aluminum nitride
substrate

YINGHUA ELECTRONIC
MATERIALS
BOOTH: 11C73



FR4 double-sided
copper clad
laminate (M7)

NTT
BOOTH: 12C709、12C710



High refractive
index resin

Wanen New Material
BOOTH: 10D506



Wanen@CA2100

Sharp Edge
Semiconductor Material
BOOTH: 10A700、10A701



Grinding Wheel

MIG Semiconductor
BOOTH: 13C79



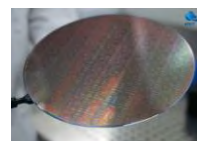
Gallium Oxide

Kefei Material
BOOTH: 12C68



AlN Packaging
Substrates

Novel Si Integration
Technology
BOOTH: 12C63



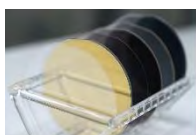
8-inch TFLN on SiPh

Epihouse
BOOTH: 13C87



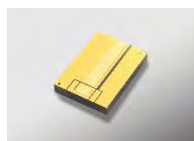
EPIWAFER

Jingzheng
BOOTH: 11A69



Thin Film Lithium
Niobate

Focuslight
BOOTH: 12B63



AuSn Pre-deposited
Substrates

Bornsun
BOOTH: 12A37



Graphene thermal
pad



Semiconductor Equipment and Manufacturing

Microview
BOOTH: 10C35



1.5μm High-accuracy Die
Bonder Mbonder-HGP

Tower Semiconductor
BOOTH: 13A76



SiPho Technology
Platform

Jingchuang advance
electronic technology
BOOTH: 10D73



JTA-9612 Fully Automatic
Grinding, Polishing and
Mounter In-line System

MRSI
BOOTH: 10B79



MRSI-705HF 5-MICRON
DIE BONDER

Attach Point
BOOTH: 10B69



AP-SMART INLINE
Semiconductor Packaging
Intelligent Inline Solution

ASMT
BOOTH: 10C61



AMICRA NANO

Thahoo
BOOTH: 10D51



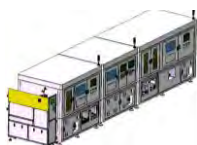
The digital intelligent back-
end production line solution
for photoelectric chips

Nactrol Semiconductor
BOOTH: 10B200、
10B201、10B202



Dispensing
controller

Yuding Interconnect
Technology
BOOTH: 10D80



TRX cover assembly
quipment

Therlicon
BOOTH:10B66



Vacuum Pressure
Oven

SINDIN
BOOTH: 12D86



Vacuum Plasma
System

Ultra Precision
BOOTH: 10B52



TP300-PLUS

Baigu intelligent industry
BOOTH: 10D211、10D212



Dispensing Vision
Control Software

Astro Plasma
BOOTH: 10C630



Microwave Asher
ASTRO PACTO-16Q

Height-LED
BOOTH: 9D86



UVLED Curing
Machine

Purbest Technology
BOOTH: 10D505



Vacuum Vapor Phase
Cleaning System
NanoVapor-90



Precision Optics Expo & Camera Expo

CIOE – Precision Optics Expo & Camera Expo is a highly influential trade show in the optical industry. The exhibition brings together leading enterprises across the entire optical industry chain, including **optical materials and components, lenses and modules, optical coatings, machine vision, AR/VR, and optical measurement**. It creates a comprehensive optical industry ecosystem, empowering downstream application sectors such as consumer electronics, advanced manufacturing, security, and medical to discover new applications and emerging demands, facilitate business communications, establish commercial partnerships, and gain insights into cutting-edge applications and emerging trends.

Hall 1 - Camera Technology and Application

- Optical Lens
- Camera Module

Hall 3 - Camera Technology and Application

- Test and Measurement
- Optical Injection / Modeling Aspherical Technology
- Sapphire Processing and Application
- Machine Vision / Industrial Automation

Hall 5 - Precision Optics Processing

- Ultra-Precision Processing
- Optical Component
- Optical Material
- Optical Processing Equipment

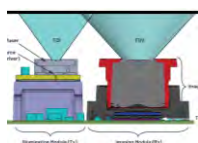
Hall 7 - Optical Vacuum Coating

- Optical Coating Material
- Optical Coating Component
- Optical Coating Equipment

Featured Products

Meta Material and Component

MetaXi Photonics
BOOTH: 3A72



dToF Transmitter Beam-
Homogenizing Metasurface
– MetaToF-Tx®

NIL Technology ApS
BOOTH: 1D32



Mass Production of
Meta-Optics

Najing
Science&Technology
BOOTH: 1A68



Metasurface DOE
products

Najing
Science&Technology
BOOTH: 1A68



Metasurface dToF
Ranging Products

[>>> View more products](#)



Module & Camera

ToupTek Photonics
BOOTH: 3B55



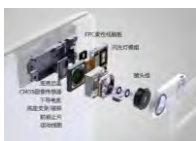
sMAX Series Scientific-
Grade Deep-Cooled C-
Mount CMOS Cameras

Hampo Electronic
Technology
BOOTH: 1B06



Dual eye synchronized
six axis IMU robot
vision module

Helicheng
Technology
BOOTH: 1D93



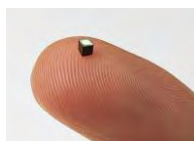
Camera module

BOSMA
BOOTH: 3E51



BOSMA 8K Full
Frame Camera B1

NIL Technology ApS
BOOTH: 1D32



metaEye™ Eye
Tracking Camera

Fangtu Digital
Technology
BOOTH: 3D17



UHD 4K Microscope
Camera for Repair and
Semiconductor Inspection

Well Vision Optical
Technology
BOOTH: 1A50



Visible light camera

PHASICS SAS
BOOTH: 3A36



QPI camera

Optical Lens

Yutong Optical
Technology
BOOTH: 1C52



Security Lens

Wavefront Optics
Technology
BOOTH: 1B23



projection lenses

Dule Precision
Manufacturing
BOOTH: 1A57



Optical lense

ALAUD OPTICAL
BOOTH: 1A88



Optical Lens

CryLight Photonics
BOOTH: 1A53



High precision
optical imaging lens

Trans Manufacture
and Trade
BOOTH: 5B52



Imaging Lenses

Accuray Phototech
BOOTH: 3D01



Laser Processing
Objective Lens

DZOPTICS
BOOTH: 3A54



Line Scan
Telecentric Lens



Optical Component

Yutong Optical
Technology
BOOTH: 1C52



Vehicle-mounted
Optical Components

Lante Optics
BOOTH: 1A63



Glass molding
aspheric lenses

NovelBeam
BOOTH: 5D33



High-Precision
Optical Filter

Yongxin Optics
BOOTH: 1A72



Automotive Optics

Grand Unified Optics
BOOTH: 1A52



Optical components

A-Star photonics
BOOTH: 5C61



LENS

Alpha Optics
BOOTH: 5A23



Spherical Lens and
Achromatic Lens

Hongcheng Photoelectric
Technology
BOOTH: 5A11



Corner Cube Prism

FRAN OPTICS
BOOTH: 1A25



DMS OPTICAL
WINDOWS

High-Resolution
Optoelectronic
BOOTH: 1B71



SPHERICAL/ASPHE
RICAL LENSES

JINGHUA
PRECISION OPTICS
BOOTH: 3A01



Glass spherical lenses with
diameters ranging from $\phi 1$ to
 $\phi 250$, high-precision machined
metal components, and optical
lenses for diverse industries

CPG Optics
BOOTH: 5A60



Optical Glass Lens

Zhenjing Optical
technology
BOOTH: 1B76



Sapphire Windows

XINJINGSHENG
ELECTRONIC MATERIAL
BOOTH: 3B66



Sapphire crystal
rods

Ruisen Optical
BOOTH: 5A65



coating filter

FOCtek Photonics
BOOTH: 1A58



High-end Life
Science Filter



Optical Component

HONGRUIDA
BOOTH: 1D35A



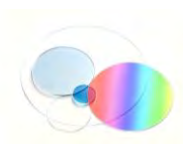
Diffuse Reflective
Spotlight Cavity

KaiXin
Optical&Eletronic
BOOTH: 5B61



GLASS WAFER

Alight-Photonics
Optoelectronic
BOOTH: 5B67



Glass Wafer

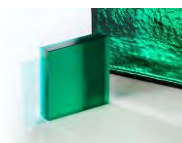
Leistungselektronik
JENA GmbH
BOOTH: 3A27



luxyr LED FLUO

Optical Material

SCHOTT AG
BOOTH: 5A62



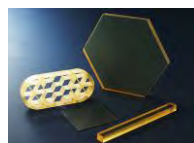
SCHOTT BG47 NIR
Cutoff Filter

HOYA GROUP
BOOTH: 5A51



Optical materials,
optical lenses

OHARA OPTICAL
BOOTH: 5B62



CLEARCERAM™-Z

Gabrielle-Optech
BOOTH: 5B20



TE series glass

QUARTECS
BOOTH: 5C51



Synthetic Quartz Tubes for Optical
Communication&Specialty Fibers

TopOlefin Advanced
Optical Materials
BOOTH: 1C62



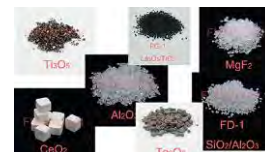
Top Optical
Polymethacrylate

HIKARI GLASS
OPTICS
BOOTH: 5C72



Optical materials
lineup

fuxingkai photo-
electronic Tech
BOOTH: 7A51



optical coating
material

eCHENG
BOOTH: 7B30



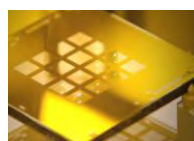
Anti-fingerprint
pellet

NAFENG
MATERIALS
BOOTH: 7B53



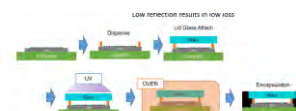
SiC

Xinxing Precision
Optics
BOOTH: 5E95



Transparent Mask
Substrate

KYORITSU
CHEMICAL
BOOTH: 1A05



Optical adhesives



Optical Coating Material and Equipment

Qingxin optical technology
BOOTH: 7A06



Sunlens coating umbrella, optical lens coating umbrella, mobile phone cover coating umbrella, workpiece rack, male rotating drum, automatic flipping workpiece rack

Soleras Advanced Coatings
BOOTH: 7A31



Target

DON OPTICS
BOOTH: 7B52



SV-88/SV-55/SV-80/SH-HT

ACETRON
BOOTH: 7B35



Evaporation coating materials

Boxin Photoelectric
BOOTH: 1B75



Optical Coating

Vitalink Technology
BOOTH: 3A50



PVD decorative coating

Shengtang Optoelectronics
BOOTH: 7B11



SiO₂

Hengye Nonferrous Metal Technology
BOOTH: 7D72



Tantalum/ Niobium targets

Bühler Leybold Optics Equipment
BOOTH: 7B51



HELIOS

SHINCRO VACUUM TECHNOLOGIES
BOOTH: 7C52



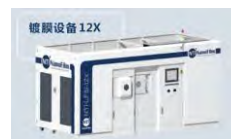
Vacuum Evaporation Coating Equipment and Magnetron Sputterin

HuiCheng Vacuum Technology
BOOTH: 7C53



Magnetron Sputtering Optical Coater

Nanofilm Vacuum Coating
BOOTH: 7A15



Standard Mold Coater

Soleras Advanced Coatings
BOOTH: 7A31



End block

Convior Technology
BOOTH: 7A40



GK series Kaufman ion source

IBD Technology
BOOTH: 7B55



Ion Beam Sputter Coating Equipment

YUNMAO
BOOTH: 7C60



PBATCH Plasma Batch ALD



Optical Processing Equipment

AMETEK Precitech
BOOTH: 3C38



Freeform TL1000

GUANGWEI OPTICAL
TECHNOLOGY
BOOTH: 3A10



FULL-AUTO
CENTERING MACHINE

Nextas
BOOTH: 1A71



Active Alignment
Assembly System for
Optical Modules

Mingzheng Electronic
Equipment
BOOTH: 5A52



High-precision 32B Double-sided
lapping and polishing machine
(5th Generation Machine)

DONGHE SCIENCE
AND TECHNOLOGY
BOOTH: 5C03



SW5030 Single Wire
Cutting Machine

XIBIN OPTO-
ELECTRONIC
BOOTH: 5C11



High-Precision Intelligent
Polishing System

PERFECT
PRECISION OPTICS
BOOTH: 5C91



Intelligent Robot
Polisher (IRP)

Satisloh
BOOTH: 5D31



SPP-200 polishing
machine

Schneider Optical
Machines
BOOTH: 5D62



SPHEROLINE® SLG 120

Jing Dian
Technology
BOOTH: 3C57



PRECISION MILLING AND
GRINDING MACHINE TOOL

Ultra Precision Nano
Technology
BOOTH: 5C81



Optical Aspheric Ultra-
precision Composite
Processing Machine

Hengtai Optical
Equipment
BOOTH: 1B65



HT1.5/4PZ
Automatic Bottom
Polishing Machine

Bozhongtaida Optical
Precision Machinery
BOOTH: 5C67



UPL-650

Bohongyuan
Equipment
BOOTH: 5C21



72B-3M4P Double-sided
polishing machine

Aviev Image
Technology
BOOTH: 1C56



Automotive camera
G7-AA

KingDing Optical
Technology
BOOTH: 1C61



Glass aspheric
precision vacuum
molding machine



Optical Measuring Instrument

TAYLOR HOBSON
BOOTH: 3C38



FORM TALYSURF®
PGI OPTICS PRO

Zygo
BOOTH: 3C39



Qualifire® laser
interferometer

Bruker Scientific
Technology
BOOTH: 3A32



ContourX-1000

CARL ZEISS
BOOTH: 3B53



ZEISS ATOS Q

Yongxin Optics
BOOTH: 1A72



STRUCTURED-LIGHT
OPTICAL SECTIONING
MICROSCOPE

TRIOPTICS
BOOTH: 3C31



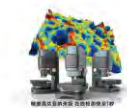
OptiCentric® 101
Dual

Panasonic Industry
BOOTH: 3B32



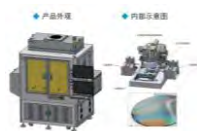
Panasonic Ultrahigh
Accurate 3-D Profilometer

ATOMETRICS
BOOTH: 3C51



Atometrics AM-7000
series WLI 3D profiler

Guangda intelligent
Technology
BOOTH: 1A60



Wafer Inspection
Machine

Xinye Optical
Technology
BOOTH: 1B52



12-inch semiconductor
inspection microscope

PREVISION
TECHNOLOGY
BOOTH: 1B82



Cammer LENS AOI

OTO PHOTONICS
BOOTH: 3A31



OCT Spectrometer-
Dubhe Series

Bellking Vibration
Reduction Equipment
BOOTH: 3A55



BK-PA-Precision air
mounts

XingQing Optical
Instrument
BOOTH: 3B21



ZPhaseStation® Laser
Interferometer Analysis
System

MARPOSS
TECHNOLOGIES
BOOTH: 3B30



Horizon 90k

Optical Metrology
BOOTH: 3C01



AIM Autocollimator-AIM-IF
Internal autocollimator-
GoniAIM goniometer



Optical Measuring Instrument

Yuchuan Optics
Instrument
BOOTH: 3A53



Laser interferometer
series

Bozhongtaida Optical
Precision Machinery
BOOTH: 5C67



Freeform surface
measuring machine

ZC Optoelectronic
Technologies
BOOTH: 3C71



Laser Confocal
Microscope (LCM-2000)

SENSHENG PRECISION
MACHINERY
BOOTH: 3D52



Air-bearing platform

Aviev Image
Technology
BOOTH: 1C56



Calibration
equipment

Shineoptics
Scientific
BOOTH: 3C53



Grain 300 Stitch
Sphere Interferometer

AcroBeam
BOOTH: 3D31



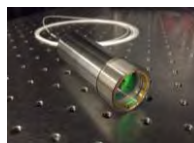
Electronic
autocollimator

Huaya Intelligent
Technology
BOOTH: 1C71



All-in-One Calibration
& Triangulation Device

LightPath Optical
Instrumentation
BOOTH: 1A77



Connectorized
Collimators

GOOD VISION PRECISION
INSTRUMENT
BOOTH: 3D53



VIP-PLUS SERIES Optical
Measuring Machine

TUOJIE PHOTOELECTRIC
TECHNOLOGY
BOOTH: 3D32



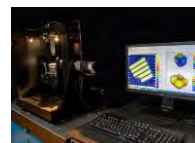
white light
interferometer

Phoskey Precision
Technology
BOOTH: 3B09



Image Dimension
Measurement System

LIGHT-ALL
BOOTH: 2E009



RiGO801-mLED near
field goniometer

TYGGO
BOOTH: 3C52



Laser
interferometer

SHUMIN INDUSTRIAL
EQUIPMENT
BOOTH: 3D35



Membrane air
springs

ideaoptics
BOOTH: 3C11



NOVA-EVO



AR & VR Expo

CIOE - AR & VR Expo focuses on the entire AR/VR supply chain, connecting upstream component suppliers, device manufacturers, solution providers, software developers, and content creators to build a full ecosystem—from core tech to end applications. It showcases **AR display modules, imaging systems, sensors, AR glasses, VR headsets**, and more, with live demos, teardowns, and case studies to boost industry adoption and commercialization.

Hall 2

- AR/VR Product and Application

Featured Products

All-in-One Machine

LUXSHARE PRECISION
TECHNOLOGY
BOOTH: 2A105



PVG Full Holographic AR Glasses

Mengtong Intelligent
Technology
BOOTH: 2A02



XR GLASSES

Mengtong Intelligent
Technology
BOOTH: 2A02



Optical Waveguide
AI+AR Glasses

Ganzin Technology
BOOTH: 2A131



Ganzin NPU chipset
eye tracking solution

AR Waveguide

Raypai Photonic Crystal
Technology
BOOTH: 2A119



HS30 – Hybrid-Waveguide
AR Optical Solution

North Ocean
Photonics
BOOTH: 2A117



YUZHANG AR
Diffractive Waveguide

SeeV Optoelectronics
BOOTH: 2A121



Full-Laminated Ultra-Thin SiC
Etched Full-Color Waveguide

NEW DIMENSION
NANO TECHNOLOGY
BOOTH: 2A161



Surface Relief
Waveguide/ SiC Optical
Waveguide

[>>> View more products](#)



Display Module, Component and Material

Hongshi Intelligent
Technology
BOOTH: 2A125



H0032 Series RGB Color
Light Engine Products

Raypai Photonic
Crystal Technology
BOOTH: 2A119



LCTA50-Large-FOV HD AR
Glasses and Display Modules

IDTE
BOOTH: 2A06



PDU optical engines of TFT,
DLP, LCOS and LBS types, as
well as interior and exterior
vehicle projection assemblies

AINSTEC
BOOTH: 2A157



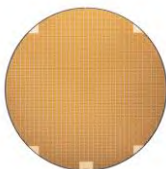
IrisGreen-AR 10

ELEPN
BOOTH: 2A156



Optical engine

SAPIEN
BOOTH: 2A04



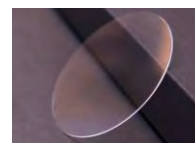
Mono-color LEDoS CMOS
Backplane (S26MM21)

Nikahood
BOOTH: 2A136



Volume holographic(VHG)
waveguide components
(AR lenses)

conant optics
BOOTH: 2E060



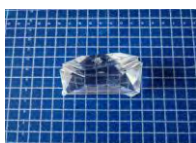
Ultra-Thin Lenses

Brilliance B.V.
BOOTH: 2A166



Brilliance RGB Neptune

Yueneng Optoelectronic
Technology
BOOTH: 2A110



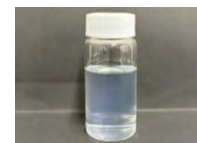
CLBO Crystal

TIMEMAKER
BOOTH: 2A112



AR array waveguide
lenses

WESTERN JAPAN TRADING
BOOTH: 2A135



Low-refractive-index coatings

Nanoimprint Lithography Equipment

GermanLitho
BOOTH: 2A103



GL310 CLUSTER GEN2

GuangDuo Micro
BOOTH: 2A108



Fully Automatic Nanoimprint
Lithography Equipment

MORPHOTONICS
BOOTH: 2A115



Cypris X700

WEINAKEYI TECHNOLOGY
BOOTH: 2A133



SCIL Nanoimprint Lithography



Manufacturing Equipment

Kangtaida Intelligent
Technology
BOOTH: 2A102



G Panel AA Optical
Engine Equipment

Colibri Technologies
BOOTH: 2A118



XR Module AA Equipment

Satisloh
BOOTH: 2E090-2/2E090-3



NEO-orbit Generator

FSTW Electronic Technology
BOOTH: 2E061



Cabinet-type Five axis
linkage glue dispensing
machine FST-320RD

Test and Measurement Instrument

Kangtaida Intelligent
Technology
BOOTH: 2A102



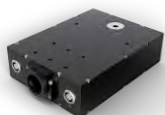
Optical Engine
Performance Testing
Equipment

Colibri Technologies
BOOTH: 2A118



RGB Optical Tester

Mvotem Optics Precision
Optical Instrument
BOOTH: 2A169



Alignment and Bonding
Opto-Mechanical
System

Seeyond
Optoelectronics
BOOTH: 2A153



Ven-WGDet

Raphael Optech
BOOTH: 2A122



StressMapper

Konica Minolta
Investment
BOOTH: 2A168



ProMetric® I151
Imaging Colorimeter

Beijing Machine Tool
Research Institute
BOOTH: 2C105



LM GUIDE BAIL SCREW
CROSSROLLER

CoreMorrow
BOOTH: 2A101



Piezo Stacks, Preloaded
Piezo Actuators

[>>> View more products](#)



Display Technology Expo

CIOE - Display Technology Expo will unite leading display technology experts and showcase cutting-edge products spanning the entire display industry chain. Serving as an ideal platform for brand exposure and new product launches, the event will feature **display materials, panels, modules, and equipment**, presenting a comprehensive ecosystem for procurement and business connections. This facilitates companies in meeting their purchasing needs, promoting technical exchanges, expanding their global reach, and achieving both brand and commercial objectives.

Hall 2

- Mini/Micro LED Microdisplay
- Automotive Display

Featured Products

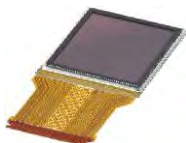
Display Module and Terminal Product

Jupiter SR
BOOTH: 2D170



65" LCD SR Display

Chip-road Electronics
BOOTH: 2D125



Micro OLED Display

Raysolve
BOOTH: 2C120



PowerMatch 1 Full-color
Micro-LED Micro-display

SMARTVISION
BOOTH: 2C130



LCoS display chip module and
whole machine products

HONGXI TECHNOLOGY
BOOTH: 2D105



Silicon based Micro
OLED micro display

Innovision
BOOTH: 2C126



Chimo@M06E

Rayvision
BOOTH: 2C135

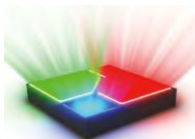


Micro OLED display



Display Chip and Material

LEKIN Semiconductor
BOOTH: 2C181、2C182



LEKIN-SiMiP® Direct
Display LED Chip

MINORU JAPAN
BOOTH: 2C180



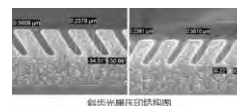
Non-silicone acrylic
thermal gasket

HaptonTech B.V.
BOOTH: 2C177



Smart Materials for
Soft Robotics

Stufor Micro-Nano
BOOTH: 2C165



Optical Waveguide
Imprint Resin

Display Manufacturing and Process Service

FodaHuangkang
BOOTH: 2C157



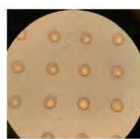
Isothermal cavity
packaging
equipment

Oudi Optical
BOOTH: 2E039



4-axis servo milling
and grinding machine

SJ company
BOOTH: 2D123



TSV Process
Service

FA Software
BOOTH: 2D150



FA Fully Auto
Solution

Test and Measurement Instrument

Wish AI
BOOTH: 2D110



Wafer Flatness
Measurement

GuangYan Tech
BOOTH: 2C151、2C152



AR/VR Optical
Tester

Institute of Metrology
BOOTH: 2E076



Display flicker rate
measuring instrument

Color Vision
BOOTH: 2C162、2C163



AR/VR/MR near-eye
test system



Lasers Technology & Intelligent Manufacturing Expo

CIOE - Lasers Technology & Intelligent Manufacturing Expo focuses on the innovative development of laser technology in downstream processing applications. The exhibition presents the latest products and technologies in **materials, lasers, laser processing, and automation equipment**, enabling downstream sectors to identify new laser applications and market demands, engage in business communications, forge commercial partnerships, and stay informed about frontier applications and emerging trends.

Hall 2

- Laser Equipment / Laser Welding
- Intelligent Equipment and Automation

Hall 4

- Laser Material and Component
- Laser Subassembly and Auxiliary System
- Lasers
- Laser Spectroscopy and Testing & Measurement
- Laser Medical Aesthetics

Featured Products

Nano Processing

Crystrong Photonics
BOOTH: 4B085



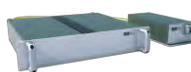
532nm High Repetition
Rate High Energy
Nanosecond Green Laser

GLORY PHOTONICS
BOOTH: 4C071



High Energy Nanosecond
Laser (NSL-HE)

GONGDA LASER
BOOTH: 4A135



300W/500W High-Energy
Nanosecond Pulsed
Green Fiber Laser (Mini)

Mite Precision
BOOTH: 2A009



Nano-Precision Ultra-
Stable Piezo Tip/Tilt
Mirror Mount

**Kaicheng Precision
Machinery**
BOOTH: 2A025



Femtosecond Micro-
nano Processing
Equipment

Husun Technologies
BOOTH: 4C217



2PP Micro/Nano 3D
Lithography System
- NanoOne250

**Guluo Photoelectric
Technology**
BOOTH: 2A100



Green light nanosecond
glass laser drilling
equipment

RFH Laser
BOOTH: 4B057



Nanosecond UV
Laser

[>>> View more products](#)



Laser Equipment

INTE LASER
BOOTH: 2A071



TGV GlassInductive
Etching Machine

LASERVALL
BOOTH: 2C071



Wafer Laser Bumping
Equipment

ZHONDUS Laser
BOOTH: 2A020



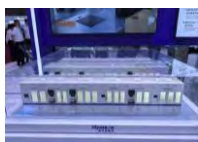
Low-power handheld
pulse cleaning head (with
small screen)

Circuit Fabology
Microelectronics Equipment
BOOTH: 2B031



WLP Direct Writing
Lithography
Solution

Hymson Laser
BOOTH: 2B105



SUS Can Battery
Assembly& Electrolyte
Filling Section Model

ANWBEST
BOOTH: 2B051



Solder Ball
Mounting Machine



Air-cooled Handheld
Laser Welding
Machine

SENHIRY Intelligent
Technology
BOOTH: 2A021



Handheld laser
marking machine

Han's Laser
BOOTH: 2B071



MDF-200Ultra-II

Optizone
BOOTH: 4B158



Odinopti @NDT
Equipmen

Kaicheng Precision
Machinery
BOOTH: 2A025



5-Axis Laser
Texturing Machine

FRIENDS LASER
BOOTH: 2C004



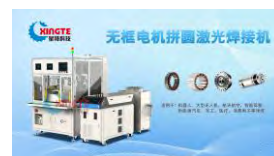
Four -station laser
welding machine for
Automotive Metal
Cameras

HGLaser
BOOTH: 4A115



AR optical waveguide high-fold
glass laser processing
intelligent production line

Xingte Technology
BOOTH: 2D019-5



Xingte Round-Assembling
Laser Welding Machine for
Frameless Torque Motors

Vi Laser Intelligent
Equipment
BOOTH: 2A012



Laser Solder Ball
Welding System

GuiHua Intelligent
Technology
BOOTH: 2A045



UV laser drilling
machine



Lasers

Han's Laser
BOOTH: 2B071



2μm thulium-doped
continuous fiber laser
(dedicated for 3D printing)

Litilit
BOOTH: 4A105



INDYLIT 20 SH

Sivers Photonics
BOOTH: 4C216



70mW/100mW 1310nm
CWDM4 CW DFB Lasers

Crystal Laser
BOOTH: 4C021、4C022



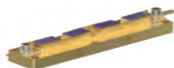
Solid laser

DG Laser
BOOTH: 4A012



DGMM6000-APP

LUMISOURCE
BOOTH: 4B095



Bar lasers

Light Conversion
BOOTH: 4C208、4C209



CARBIDE Industrial
Femtosecond Lasers

COREOPTICS
BOOTH: 4A010、4A011



CW Laser

Luxinar Laser
BOOTH: 4A175



Ceramicore® series
CO2 laser

GONGDA LASER
BOOTH: 4A135



4000W Single-Mode
Continuous-Wave Green
Fiber Laser

Donglai Technology
BOOTH: 4A045



High-power Single-
frequency Laser

Laser Opto
BOOTH: 4C222



Distributed Bragg
Reflector Laser
(DBR)

Elite
Optoelectronics
BOOTH: 4B125



Solid-state/Semiconductor
High Stability Laser

Excimer Laser Tech
BOOTH: 4C180



EXCI Excimer Laser
Ablation System For
ELCA

Fengruicheng New
Materials
BOOTH: 4D175



Gun aiming laser

Reliable Photoelectric
Technology
BOOTH: 2B057

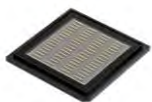


FL300/500 Air-
Cooled Continuous
Fiber Laser



Laser Material and Component

Everbright
BOOTH: 4A071



65W High power diode
single emitter chip

CSRAYZER
BOOTH: 4A025



Active Devices and
Laser Modules

DXS OPTICS
BOOTH: 4A095



Laser Lenses

Compound
Semiconductor
BOOTH: 4D205



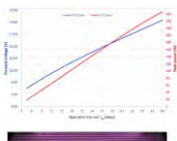
Boron-doped
diamond

Shafan Optoelectronic
Technology
BOOTH: 4B175



Laser Power Meter

Raybow
Optoelectronics
BOOTH: 4A085



905nm EEL for
LiDAR

Ruik-Tech
Communication
BOOTH: 4B200



High Power Fiber
Isolator

Deray
Optoelectronics
BOOTH: 4B025



SLED 840/850/1310nm
(Superluminescent Diode)

Hurricane Chip
BOOTH: 4B145



Laser Diode

FREEGES
ELETROMECHANICAL
EQUIPMENT
BOOTH: 4C085



Voice coil motor
module

CRYSTECH
BOOTH: 4D125



Laser Crystal

Daheng Optics
BOOTH: 4C105



Fiber lens

BRIGHT DLODE
LASER
BOOTH: 4C125



VCSEL

Wuyue Optical
Technology
BOOTH: 4C158



Fiber laser
protective lens

SiCART
BOOTH: 4A215



Nx1 Pumping
Combiners

Lightstar
BOOTH: 4B195



3W-U type High
power Circulator



Test and Measurement Instrument

JINSP
BOOTH: 4C025



OCT Spectrometer

Oeabt Optical
Technology
BOOTH: 4A200



Miniature Fiber-
Optic Spectrometer

Optic Electronic
Tech
BOOTH: 4D090-2



Stress Birefringence
Measurement System

Besi Optoelectronic
Technology
BOOTH: 4D199



High-performance
spectrometer

GMD TECH
BOOTH: 2D037



NanoSystem 3D
Measurement &
Inspection System

Brolight Technology
BOOTH: 4D061、4D062



BIM-780X High Speed
Photodetector

Focuslead
BOOTH: 4E060、4E061



MDI-Micro Detector
Interferometer

VoyaWave Optics
BOOTH: 4B190



Optoprism Coupler

Mechanical System & Numerical Control System

Jingcui Optical
Technology
BOOTH: 4C065



Cage Translation Stages
with SM2 Optic Mounts

Red Star Yang
BOOTH: 4C012



Electric
displacement table

DDHC Technology
BOOTH: 4D168、4D169



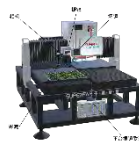
Ultra-High Precision
Motorized Linear Stage

Xindong Intelligent
Technology
BOOTH: 4C041



Manual Linear
Stage

SuperFar
BOOTH: 2B017



QLScan Precision Platform +
Galvo+ Vision Control System

POWERLAND
BOOTH: 2A007



The platform for CNC
Development & CNC Systems

Aerotech
BOOTH: 2A001、2A002



Hexapod Six-DOF
Positioning System

Zmotion
BOOTH: 2A090



Laser Galvo & Machine
Vision Motion Controller
VPLC716SCAN

[>>> View more products](#)



Infrared Applications Expo

CIOE - Infrared Application Expo stands as a preeminent professional platform for infrared technology in the Asia-Pacific region. The exhibition will display innovative **materials and devices to sophisticated equipment and applications in the fields of infrared, ultraviolet, and terahertz**. This event serves as a nexus for enterprises across various sectors such as power, security, consumer electronics, and energy, enabling them to scout for innovative products, exchange state-of-the-art technologies, and identify upcoming trends.

Hall 8

- Infrared Thermal Imaging Technology and Application
- Night Vision Device and Application
- Imaging Instrument Inspection System and Equipment
- Infrared Temperature Measurement and Material
- Ultraviolet Technology and Application

Featured Products

Night Vision

JIUZHUYANG
INFRARED SYSTEM
BOOTH: 8B31



Series Low-altitude
Defense System

Tritron Technology
BOOTH: 8A69



Horus-E

Changjiang Optics Electron
BOOTH: 8A32



IR Combo Red Dot
Sight

SHENZHI WEILAI
BOOTH: 8A79



DT-S3 Night Vision
Camera

ADNV-Advanced
Digital Night Vision
BOOTH: 8B61



Advanced Fusion Sight
Digital Night Vision Goggle-
Binocular ADNV-GF31

SailRay Optical
Technology
BOOTH: 8A59



ENHANCED NIGHT
VISION BINOCULAR
GOGGLES

MetaOrigin Intelligent
Systems
BOOTH: 8D43、8D44



YL-W1 Full-Color
Night Vision Gimbal

jingjieoptical
BOOTH: 8E48



Low-Light Night
Vision Device



Infrared Equipment and Imaging

Vital Optics Technology
BOOTH: 8C61



Infrared thermal
imaging

Guide Infrared
BOOTH: 8A49



Vehicle-mounted infrared
integrated device

JIUZHUYANG
INFRARED SYSTEM
BOOTH: 8B31



Series Infrared
Thermal Imager

Raytron Technology
BOOTH: 8B59



PM7 Series Multi-
spectrum Sphere
Positioning System

FJR OPTOELECTRONIC
BOOTH: 8A59



VOCs infrared
imaging gas detector

Xintai Instrument
BOOTH: 8B63



HT-D01 Series Four-in-One
Multi-functional Thermal
Imager

Xintai Instrument
BOOTH: 8B63



HT-C523 Mobile Dual
Infrared Thermal Imager

Zhaosheng Technology
BOOTH: 8B21



HM Series Thermal Imaging
Dual-Band Dome Camera

Zhaosheng
Technology
BOOTH: 8B21



YS Series Small Side-Lift
Dual-Band Pan-Tilt Unit

Kunteng Photonics
Technologies
BOOTH: 8B29



Infrared thermal imaging
gas leak detector

EVERBEST MACHINERY
INDUSTRY
BOOTH: 8C101



Professional Infrared Thermal
Imager with Telephoto function

Uni-Trend Technology
BOOTH: 8A61



Infrared Acoustic Imager

Raysart Technology
BOOTH: 8C10、8C11



Cooled Infrared
UAV-borne Payload

DYNACAST
BOOTH: 8C64



Handheld Thermal
Camera

Raysart Technology
BOOTH: 8C10、8C11



F7(E) - Cooled MWIR
Science-Grade Camera

SPARKLE
TECHNOLOGY
BOOTH: 8C26



MP8-U Multifunctional
Thermal Imaging Binocular



Infrared Module and Lens

GRINM Guojing
Advanced Materials
BOOTH: 8D65



IR Lens

Raytron Technology
BOOTH: 8B59



Automotive-Grade
Thermal Imaging Module
Horus1280AW

Changhong Photoelectricity
BOOTH: 8A21



ZL13L Medium Wave
Cooled Continuous
Zoom IR Lens

Wavelength
BOOTH: 8B66



Infrared module
lens

InRight Technology
BOOTH: 8E22、8E23



Industrial-Grade CQD-SWIR
Camera IR-S01210AG

Tuogan Technology
BOOTH: 8B69



Greendragon Series
M6515-CS04 Module

Kunteng Photonics
BOOTH: 8B29



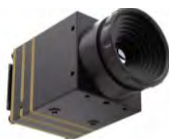
Infrared AD module,
C01 movement module

VISION INFRARED
BOOTH: 8C71



VZ35301212 (E001),
continuous zoom
lens

JIASAI TECHNOLOGY
BOOTH: 8D81



Infrared Thermal
Imaging Camera

SHENZHI WEILAI
BOOTH: 8A79



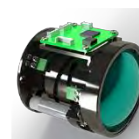
B3 Automotive Full-Color
Night Vision Module

Huaguo Optical
BOOTH: 8D73



Drone/ Vehicle / Phone
accessory-LWIR lens

Photoelectric
Science&Technology
BOOTH: 8A66



MWIR Cooled Zoom
Lens 19-275mmF5.5

Phynan Intelligent
Technology
BOOTH: 8A46



Hyper 9-13 HD

JIANANYING TECHNOLOGY
BOOTH: 8C16、8C18



Laser Rangefinder

Quansight
BOOTH: 8E71



384-4/640-9.1

View Sheen
BOOTH: 8A29



SWIR Camera Module



Infrared Component

Guide Infrared
BOOTH: 8A49



ApexCore Next-Gen
High-Performance IR
Detector

FJR OPTOELECTRONIC
TECHNOLOGY
BOOTH: 8A59



Uncooled Series Core

Tritron Technology
BOOTH: 8A69



640×512 (15μm)
MW MCT IDDCA

Daheng Optical
Thin Film
BOOTH: 8C15、8C17



Raman Filter Group

GRINM Guojing
Advanced Materials
BOOTH: 8D65



Infrared Optics

Yudi Optical
BOOTH: 8E18



Aspherical Lens
Processing and Coating

MULTI IR TECHNOLOGY
BOOTH: 8B81



Sensitive Infrared
Filters

Hope Sensor
BOOTH: 8D82



Infrared detector
and components

DALI
BOOTH: 8B51



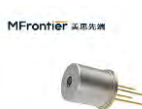
Uncooled focal
plane detector

InfraTec
BOOTH: 8B01、8B02



PyrIQ® Digital Detector

MemsFrontier Electronics
BOOTH: 8D10、8D11



Infrared thermopile
array sensor

Lihan Cryogenics
BOOTH: 8B88



SymCool series Linear
Stirling Cryocooler (TC2770)

Raytron
BOOTH: 8B59



Industry-First SWLP-
Based 8 μm Infrared
Detector OHLE 6081

Tuogan
BOOTH: 8B69



1280x1024/10μm
MWIR Detector(Split)

I6TH RESEARCH INSTITUTE
OF CHINA ELECTRONICS
TECHNOLOGY GROUP
BOOTH: 8A23



stirling cryocooler

jingjieoptical
BOOTH: 8E48

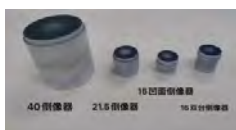


ICR + Lens Assembly



Infrared Material

China Building
Material Academy
BOOTH: 8D64



GRINM Guojing
Advanced Materials
BOOTH: 8D65



Sinoma Synthetic Crystals
BOOTH: 8B22



Changhong
Photoelectricity
BOOTH: 8A21



Fiber Optic Inverter
(FOI)

Weimi Optics
BOOTH: 8A55



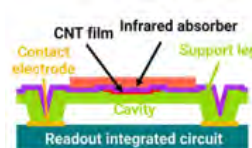
Germanium/Silicon

Carbon Semiconductor
BOOTH: 8E37



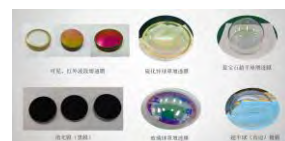
Ultra-low thermal
expansion glass ceramic

Carbon Semiconductor
BOOTH: 8E37



Customised and
processing infrared
material

Anmei Tech
BOOTH: 8C20



Dome、Window

Carbon Nanotube
Network Wafer

Carbon-Based Infrared
Sensor Material and
Device Process Solutions

Optical Coating

YINGRUIGUANG
BOOTH: 8E53



Tuocai Technology
BOOTH: 8D130、8D131



CNBM
BOOTH: 8D28



CNBM
BOOTH: 8D28



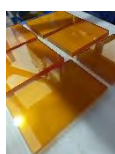
chalcogenide glass

High-purity
compound

Selenium

Antimony

Longsee
BOOTH: 8E54



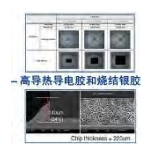
Jingjian
Optoelectronic
BOOTH: 8D22



Xinyue Semiconductor
BOOTH: 8D53、8D54



MICROHESION
BOOTH: 8E101



ZNSE

Infrared silicon

InGaAs epi-wafer

High thermal
conductivity Ag
paste and sintering
paste



Test and Measurement Instrument

Thorlabs
BOOTH: 8A51



SWIR Camera Beam Profiler

Thorlabs
BOOTH: 8A51



SWIR Camera Beam Profiler

EVERBEST MACHINERY
INDUSTRY
BOOTH: 8C101



AI-7760 Three-Phase
Power Quality Analyzer

HGH Infrared Systems
BOOTH: 8B17、8B18



OPALIN COLLIMATOR

HGH Infrared Systems
BOOTH: 8B17、8B18



IRCOL TEST BENCH

JIASAI TECHNOLOGY
BOOTH: 8D81



Laser rangefinder

Longshuo Technology
BOOTH: 8D106



Laser Rangefinder Binocular

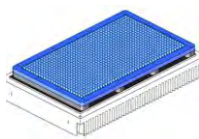
Jiugong Technology
BOOTH: 8B10、8B11



Infrared thermometer

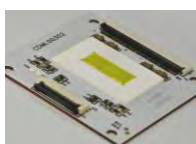
Terahertz and UV Technology

Bytech Electronics
BOOTH: 8B96



3D Printing mini LED
matrix light module

Bytech Electronics
BOOTH: 8B96



Micro LED digital
headlights

Daheng Optical Thin
Film Center
BOOTH: 8C15、8C17



Solar Blind Filter

LEDINTRO Technology
BOOTH: 8C21



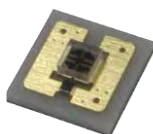
PW UV Chips 230-
340nm

LEDINTRO Technology
BOOTH: 8C21



230nm Domestic
Packaged LED Beads

Caeds Industries
BOOTH: 8C19



NF Series UVC LED

Huirui Optics Technology
BOOTH: 8D12、8D13



Rigi Terahertz Camera

Xinhai Future
BOOTH: 8D15



High-Resolution UV
Scientific Camera



Intelligent Sensing Expo

CIOE - Intelligent Sensing Expo specializes in intelligent sensing technologies and application solutions. The exhibition presents a complete showcase of new products, technologies, processes, and applications across the sensor industry—including **3D vision, 3D imaging and sensing, LiDAR, millimeter-wave radar, MEMS, and sensors**—with a focus on emerging demands in consumer electronics, autonomous driving, communication electronics, and advanced manufacturing. It promotes business communications and commercial partnerships across the sensor industry value chain while delivering insights into frontier applications and emerging trends.

Hall 6

- 3D Vision and Imaging
- LiDAR & Quantum Sensing
- Industrial Sensor and Testing & Inspection System
- Embodied Robot

Featured Products

LIDAR and Chips

Vertilite
BOOTH: 6A29



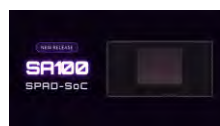
VCSEL

LEMOM Photonics
BOOTH: 6C05、6C06



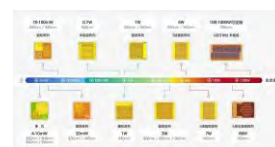
VCSEL Laser Chip

SophotonTechnologies
BOOTH: 6C37



SA100 SPAD-SoC

RAYSEES
BOOTH: 6B59



VCSEL Chips (Die)

QuantumCTek
BOOTH: 6B52



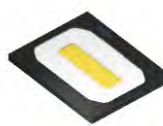
Free-Running Single
Photon Detectors

Huayu Automotive
Systems
BOOTH: 6D61-2



X2_S78 LiDAR

ams OSRAM
BOOTH: 6A59



EVIYOS™ Shape

Leiting Photoelectric
BOOTH: 6D141、6D142



0402 VCSEL



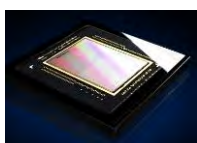
3D Imaging and Sensing

LDRBOT
BOOTH: 6B33



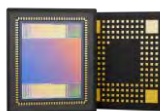
Sensor

visionICs Microelectronics
BOOTH: 6C51



VR9150

PolarisIC Microelectronics
BOOTH: 6C56



PCM7200 Photon-
Counting Image Sensor

PolarisIC Microelectronics
BOOTH: 6C56



PSC2503 Medium-Range
High-Frame-Rate

LEMON Photonics
BOOTH: 6C05、
6C06



1D Addressable Speckle
VCSEL Module

BRIGATES MICRIELCTRINCS
INCBOTH: 6A56



Ultra-high-speed deep ultraviolet
TDI-ECCD linear camera

Galaxycore Shanghai
BOOTH: 6D61-3



OIS Package

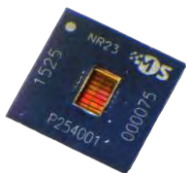
MEGA PHASE
BOOTH: 6C01、6C02



Sizector 3D Camera SQN Series

Spectral Sensing

HongKe
BOOTH: 6C07、6C08



ChipSense™ Spectral
Sensor Chip

Spectricon SM PC
BOOTH: 6A06



MUSES9-HS Tunable filter
hyperspectral camera

Leiting Photoelectric
BOOTH: 6D141、6D142



3535 VCSEL

Unispectral Optoelectronics
BOOTH: 6D35



Venus-Element Hyperspectral
Imaging Camera

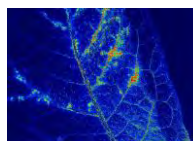
Unispectral
Optoelectronics
BOOTH: 6D35

PROCHEM
BOOTH: 6D25、6D26



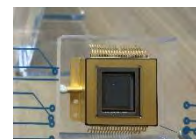
Spectrophotometer
CM-3700A PLUS

Spectricon SM PC
BOOTH: 6A06



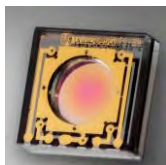
LAMBDA 3+ hyperspectral
data analysis software suite

Spectrum On-chip
BOOTH: 6A15



SWIR00150-NA9 Spectral
Detector

ColorIR VIS/NIR
Tunable Filter Chip

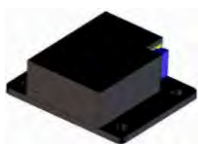


>>> [View more products](#)



Industrial Sensors

KODENSHI
BOOTH: 6B69



Laser Light Source
Module

BRIGATES MICRIELCTRINCS
BOOTH: 6A56



TDI-ECCD high
speed CXP camera

Micro-Epsilon Measuremen
BOOTH: 6C49



optoNCDT

Tronlight Intelligent
BOOTH: 6C22



Laser triangle
displacement sensor

Inxun
BOOTH: 6A42



Balanced
Photodetector

Hypersen
BOOTH: 6D05、6D06



3D Line Confocal
Sensor

Actech Sensors
BOOTH: 6E02



Butterfly Laser

Guangchuan Intelligent
BOOTH: 6E06



Fiber Bragg Grating
Sensor

Kemin Electronics
BOOTH: 6E65



Angular Displacement
Sensors

Trusee Microsystems
BOOTH: 6D151



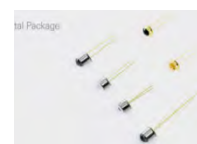
IX-W10

Cizheng intelligent
BOOTH: 6D38、6D39



Double-code channel
absolute value magnetic
scale encoder

ODTech
BOOTH: 6B03、6B04



industrial discrete

Test and Measurement Instrument

Micro-EpsilonCMeasurement
BOOTH: 6C49



capaNCDT

Sidea Semiconductor
BOOTH: 6A25



Next Generation 12" Full-
Auto Prober GT-3000

KOWINTEST EQUIPMEN
BOOTH: 6A28



2-zone Thermal Shock
Test Chamber

HongKe Technology
BOOTH: 6C07、6C08



Optical Coherence Tomography
Imaging System



Test and Measurement Instrument

Bixuan Information
BOOTH: 6E49



xDAQ-5000

HLT Optical
BOOTH: 6D136



400G/800G O+C+L band
QAM module

Sanhui Optoelectronic
BOOTH: 6D11



BOTDR/BOTDA/DAS
/DTS/DVS

PROCHEM
BOOTH: 6D25、6D26



GlossEye Imaging Gloss
Measurement System

Fusi Jingyi
BOOTH: 6E15、6E16



Optical Fiber Distributed
Reflectometry

LINK Fluid
BOOTH: 6D147



Six Degree of Freedom
Photonic Alignment Stages

HongKe
BOOTH: 6C07、6C08



eBUS edge

Jucan Photoelectric
BOOTH: 6E48



Frame Grabber

MYSOOW
BOOTH: 6D23、6D24



High-speed Data
Acquisition Card

Fusi Jingyi
BOOTH: 6E15、6E16



Dynamic Parameter
Measuring Instruments

Smartmens
BOOTH: 6D45



nano CDMS3020

Quanhom
BOOTH: 6D27、6D28



UltraVision Precision
Optical Testing System
(UPOTS)

[>>> View more products](#)



Photonics Innovation Expo

CIOE - Photonics Innovation Expo features cutting-edge optoelectronic technologies from **top research institutes, universities and hi-tech companies**, focusing on their incubator's latest products. It is a holistic photonics platform that connects optoelectronic businesses and investors with research resources, facilitate precise connections between optoelectronic companies and investment institutions, foster business communication, achieve commercial cooperation, and gain insights into emerging trends and frontier applications.

Hall 6

- Scientific Institute / University
- High-tech and Innovative Enterprise

Featured Products

ExploreX
BOOTH: 6B86.33、
6B86.34

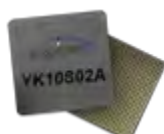


Image Signal
Processor (ISP)
Chip

Seetrum
BOOTH: 6C82-2



Physical AI Vision
Chip

Optoelectronics
BOOTH: 6B90



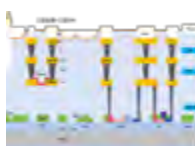
Packaging, Testing
and Analysis
Services

Advanced Micro
BOOTH: 6A80-4



850 nm 50G/100G/200G
VCSEL Process Platform

SIMIC
BOOTH: 6A80-2



12-inch 180nm
Silicon Photonics
Process Platform

TAN KAH KEE
BOOTH: 6D128



Micro-nano
Fabrication Center

XINGLONG LAKE
BOOTH: 6C118、 6C119



Wafer Level
Metasurface

H-Chip
BOOTH: 6C82



Metasurfaces



Featured Products

Fit Optical
BOOTH: 6C88



Aspheric optical
element

BIT CHONGQING
INSTITUTE
BOOTH: 6D88



Micro-mirror Array
Chip

WisMicro Imaging
BOOTH: 6D83、6D85-1



UV relay lens&Wide field-
of-view objective lens for
space cameras

TSD
BOOTH: 6A97



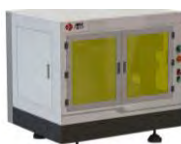
Fully-Automatic
Grinding Machine

CHANGGUANG DAQI
BOOTH: 6B86.18、
6B86.21



DQ-5 MRF

Niviphx
BOOTH: 6D130



Phase-change laser
direct writing
system HDL-A100

Kurt Lesker
BOOTH: 6D129



Physical Vapor
Deposition
Equipment-PVD200

Yuanrong
BOOTH: 6C116、6C117



Reactive magnetron
sputtering coating
machine

HENGGUANG
BOOTH: 6B86.39



GODAS-Optical
Design

HengMai Optics&Fine
BOOTH: 6B103、6B105



Four-Station Ultra-Smooth
Polishing Platform

Peking University
Yangtze Delta
BOOTH: 6A86



High-Content Panoramic
Super-Resolution Imaging
and Analysis System

X-CMOS
BOOTH: 6A107



CMOS Detector

ZPHER
BOOTH: 6A91



High Precision Beam
Measuring Unit

Sailham
BOOTH: 6B106、6B107



UV Accelerated
Aging Test Chamber

Changguang Detecting
BOOTH: 6B886.29、
6B86.30



High-Precision Cavity-Enhanced
Spectroscopy Gas Analysis
Series Products

GD-SemiTech
BOOTH: 6D126



Semiconductor
Micro-Nano Facility



VIP Buyer Program

VIP Buyer Program is exclusively designed for key buyers and senior decision makers from the optoelectronic industry, who have specific sourcing needs or purchasing plans. CIOE offers **One2One Business Matchmaking** service to help buyers fast connect with matchable exhibitors/suppliers. This tailored service facilitates more precise and efficient procurement connections for buyers. [>>> Register as a VIP Buyer](#)

How to join One2One Business Matchmaking

Step 1: Submit your sourcing request

Step 2: The CIOE team will provide a curated exhibitor list aligned with your sourcing needs.

Step 3: Confirm the exhibitors you're interested in meeting with.

Step 4: The CIOE team will pre-arrange the 1-on-1 meetings at the VIP lounge for you.

2026 Buyer Sourcing Request

Accelink

amazon

HUAWEI

molex

optronics®

Buyer ID	Product Category	Sourcing Request	Country/Region
2026074301	Optical Lens	f-theta lens, meta-lens, micro lens array for LiDAR sensors	Singapore
2026074302	Lasers	Narrow-linewidth tunable laser (ECL/DFB) - 1550nm & 1310 nm, linewidth <100kHz, chirp bandwidth 10-30GHz+	Singapore
2026074303	LiDAR	FMCW LiDAR - for robotics application	Singapore
2026074304	3D Sensing	3D sensor for robotics / automation/ intelligent system	Singapore
2026074305	Optical Component	> 8 channel - FAU; Free space splitters, circulators, isolators	Singapore
2026074306	Laser Component and Auxiliary System	Laser driver	Singapore

[>>> View all 2026 Sourcing Requests](#)

Delegation Registration

- **3 Delegates and more**
- Delegation Welcome Gift
- First-hand Visiting Guides
- Invitation Letter for VISA Application
- CIOE 2025 eCatalogue (Limited Quota)

[Download and fill out the <2026 Delegation Registration Form>](#), email to Ms. Carrie Wu Carrie.Wu@CIOE.CN



CIOE 2026 Conference List

Date	Venue	Conference	Language
September 9 th - AM	Mangrove A, Second Floor, South Lobby	The 27th China International Optoelectronic Expo Opening Ceremony & 2026 IEEE Optoelectronics Global Conference Keynote Speech	CN/EN
September 9 th - PM	9B, 2nd Floor, Hall 9	Global Photonics & Semiconductor Industry Development Forum	EN
Information and Communication Industry Development Forum			
September 9 th - PM	9A, 2nd Floor, Hall 9	High-Speed Optical Transmission Technology Innovation in AI Era Forum	CN
September 9 th - PM	9C, 2nd Floor, Hall 9	10 Gigabit Optical Access: AI+ Intelligent Upgrade and Application Forum	CN
September 9 th - PM	Conference Room, Hall 13	Optoelectronics Industry Summit – The "Core" Future of Optoelectronics	CN
September 9 th - PM	14B, 2nd Floor, Hall 14	2026 Shenzhen International MicroLED & CPO Industry Innovation Summit Forum	CN
September 10 th - PM	Conference Room, Hall 13	ePIXfab China-Europe Silicon Photonics Forum	CN/EN
September 10 th	9B, 2nd Floor, Hall 9	Optical Interconnect Technology for AI Computing Clusters Forum	CN/EN
September 10 th	9C, 2nd Floor, Hall 9	Photonics-Electronics Convergence Technology and Industrial Development Forum	CN/EN
September 11 th - AM	9C, 2nd Floor, Hall 9	AI+ Novel Optical Fiber Utilization & Deployment Forum	CN
Global Conference on Precision Optical Technology and Applications			
September 9 th - PM	5A, 2nd Floor, Hall 5	"AI + Computational Optical Imaging" New Opportunities Forum	CN
September 9 th - PM	5B, 2nd Floor, Hall 5	Optical Semiconductor Inspection Technology Forum	CN
September 9 th - PM	5C, 2nd Floor, Hall 5	Nanoimprint Manufacturing Technology Forum	CN
September 9 th - PM	1A, 2nd Floor, Hall 1	The Development and Application of Ophthalmic Imaging Sensing Technology Forum	CN
September 9 th - PM	Conference Room, Hall 3	CIOE2026 Precision Optics "New Product Launch" Special Event	CN
September 9 th - PM	Conference Room, Hall 7	EPIC TechWatch at CIOE - Optics Innovation Across the Value Chain: Materials, Manufacturing, Metrology, Integration, and Systems	CN
September 10 th - AM	5A, 2nd Floor, Hall 5	Meta-optical & Micro-nano Optical Manufacturing Technology Forum	CN
September 10 th - PM	5A, 2nd Floor, Hall 5	Optical Ultra-precision Manufacturing Forum	CN
September 10 th - AM	Conference Room, Hall 3	Medical Endoscopic Imaging Technology Forum	CN
September 10 th - PM	Conference Room, Hall 3	Handheld Intelligent Imaging Device Technology Development Forum	CN
September 10 th	Conference Room, Hall 7	Optics Vacuum Coating Forum	CN
September 11 th - AM	Conference Room, Hall 3	2026 Precision Optical Molding Aspheric Surface Processing Technology Forum	CN
September 11 th - AM	Conference Room, Hall 7	Optoelectronics-Driven New Quality Productive Forces in Low-Altitude Economy Forum	CN
Laser Technology Innovation and Application Forum			
September 9 th - PM	2C, 2nd Floor, Hall 2	Laser Micro and Nano Processing Advanced Manufacturing Forum	CN
September 9 th - PM	Conference Room, Hall 4	Laser Welding for Smart Manufacturing Innovation Application Forum	CN
September 9 th - PM	2A, 2nd Floor, Hall 2	Laser Technology Empowering Semiconductor Industry Manufacturing Forum	CN
September 10 th	Conference Room, Hall 4	Laser Technology Empowering Medical Development Forum Session 1: Optics/Laser Medical Session 2: Medical Cosmetology	CN
September 10 th - PM	1A, 2nd Floor, Hall 1	Water Guided Laser Precision Processing Technology and Application Forum	CN
September 10 th	2AB, 2nd Floor, Hall 2	The 20 th National Laser Processing and Systems Conference	CN



Date	Venue	Conference	Language
Infrared Industry Insight and Application Forum			
September 10 th	6C, 2nd Floor, Hall 6	The Infrared Detection Technology and Application Forum	CN
September 10 th	Conference Room, Hall 8	Intelligent Inspection and Predictive Maintenance under Industry 4.0 Forum Session 1: Petroleum Application Session 2: Chemical Engineering Application	CN
September 10 th - PM	6D, 2nd Floor, Hall 6	2026 Petrochemical Intelligent Safety Operation and Maintenance Closed-door Seminar (Invitation Only)	CN
Quantum Technology Industry Forum			
September 10 th	5B, 2nd Floor, Hall 5	International Quantum Technology Scientific Frontier Forum	CN
Electronics-Photonics Convergence Forum			
September 10 th	1C, 2nd Floor, Hall 1	Advanced Photonic Technology Forum	CN
Yole Group Forum			
September 10 th - AM	Conference Room, Hall 13	Photonics at the Core of the AI Vortex: An Overview of the Industry	EN
Optoelectronic+ Application Forum			
Optoelectronic+ Automotive			
September 9 th - PM	1B, 2nd Floor, Hall 1	The 5 th Automotive Camera Technology and Testing Forum	CN
September 10 th	9A, 2nd Floor, Hall 9	Automotive Optical Communication Technology Innovation and Application Forum	CN
September 10 th	5C, 2nd Floor, Hall 5	The 8 th Intelligent Vehicle Technology Forum	CN
Optoelectronic + Robot			
September 10 th - AM	1A, 2nd Floor, Hall 1	Smart Optics for Embodied AI Forum	CN
September 10 th	6A, 2nd Floor, Hall 6	Embodied Intelligent Robots Integrated Application Forum	CN
Optoelectronic+ AR&VR			
September 9 th - PM	Conference Room, Hall 2	Global Spatial Computing Industry Forum	CN
September 9 th - PM	2B 2nd Floor, Hall 2	AR/VR Optical Technology Application Summit Forum	CN
September 10 th	2C, 2nd Floor, Hall 2	AI AR Glasses Industry Development Forum	CN
September 11 th - AM	Conference Room, Hall 2	Large-Scale Interaction and Immersive Experience Technology Summit	CN
Optoelectronic+ Display			
September 10 th	Conference Room, Hall 2	Global Microdisplay Industry Development Forum	CN
Optoelectronic+ Intelligent Sensor			
September 9 th - PM	6B, 2nd Floor, Hall 6	2026 Intelligent Sensing and Advanced Instrument Innovation and Development Forum	CN
September 10 th - PM	Media Center A, Level 1, South Lobby West	2026 SEG 2nd Workshop on Fiber Optics Sensing	CN
September 10 th	6B, 2nd Floor, Hall 6	The 41st MEMS Seminar: 3D Sensing and Imaging Technology Application	CN
September 11 th - AM	1C, 2nd Floor, Hall 1	Advanced Optics and Intelligent Sensing Technology Forum	CN
Optoelectronic+ Consumer Electronics			
September 9 th	6A, 2nd Floor, Hall 6	2026 Smart Home Development Trends Forum	CN
Optoelectronic+ Security			
September 9 th - PM	6C, 2nd Floor, Hall 6	The 4rd AI Security and Vision Technology Innovation and Development Forum	CN
Optoelectronic+ Astronomy			
September 9 th - AM	Conference Room, Hall 3	Interstellar Vision, Light Accompanying - CIOE2026 Astronomical Forum	CN



Date	Venue	Conference	Language	Price
2026 Chinese Optical Society Academic Conference				
September 10 th -12 th	Hall18	2026 Chinese Optical Society Academic Conference	CN	Registration fees (before August 15) Member:1600RMB Non-Member:2100RMB Student (Member) :1000RMB Student (Non-Member): 1200RMB Registration fees (After August 15) Member:2000RMB Non-Member:2500RMB Student (Member) :1200RMB Student (Non-Member): 1400RMB Call for papers and registrations: https://meeting.cncos.org.cn/cosconf2026/index.htm
2026 IEEE OGC Academic Conference				
September 8 th -11 th	LM Conference Room, Level 1, South Lobby West	S1. Laser Technology S2. Optical Communication and Networks S3. Metamaterials and Photonic Crystals S4. Quantum Optics and Information S5. Fiber-Based Technologies and Applications S6. Optoelectronic Devices and Applications S7. Biophotonics and Optical Biomedicine S8. Data Center Optical Interconnects and Network S9. Silicon Photonics S10. Computational Imaging Special Sessions: T1. Mid Infrared Lasers and their Applications、 T2. Photonics for Ocean、 T3. Optoelectronics EDA Software、 T4. Emerging Technologies for Advanced Optical Lithography、 T5. Optical Communication and Sensing Technologies Workshop: W1. Optical Fiber Upgrade	EN	IEEE Member:3500RMB Non-IEEE Member:3850RMB Student (IEEE Member) :2800RMB Student (Non-IEEE Member): 3150RMB Call for papers and registrations: http://www.ipsogc.org/index.html

The agenda is subject to change. Please visit <https://conference.cioe.cn/en/ConferenceList.html> for updates.



ONE PASS FOR THREE EXHIBITIONS Building a Photonics-Semiconductor-Electronics Ecosystem

The **27th China International Optoelectronic Exposition (CIOE 2026)**, the **International Integrated Circuit Innovation Expo (IICIE 2026)**, and the **23rd Shenzhen International Electronics & Embedded Systems Expo (elexcon 2026)** will take place concurrently at the Shenzhen World Exhibition & Convention Center, China from September 9-11, 2026. Spanning 320,000 square meters, it will bring together over 5,000 exhibitors and 240,000+ industry professionals. Together, these events create a premier platform that seamlessly integrates technology showcases, industry networking, and commercial partnerships, driving powerful innovation momentum across optoelectronics, integrated circuits, electronics, and embedded systems.

The exhibitions focus on four strategic technologies: **AI computing power, consumer electronics & AR/VR, intelligent automotive and embodied robot, semiconductor and intelligent manufacturing**. By connecting upstream and downstream technologies, supply chains, and business opportunities, the events accelerate cross-industry innovation and drive deeper value chain convergence.

➤ Empowering AI Computing Power: Building an Integrated Industrial Ecosystem of Photonics, Storage, Electronics and Chips

The large-scale deployment of AI computing power represents a comprehensive systematic initiative encompassing chips, servers, high-speed interconnections, mass storages, intelligent computing power supplies, and data center clusters. This ecosystem is built upon four core industrial pillars: **photonics, storage, electronics and chips**. The three co-located exhibitions feature well-defined positioning and complementary convergence, covering the full-spectrum requirements of computing infrastructure:

- **Photonics: The Foundational Backbone for High-Speed Optical Interconnect of Computing Clusters**

Photonics technology addresses the critical demand for ultra-high-speed data transmission between servers during large-scale model training and inference, serving as the core carrier for interconnection of computing networks.

- **Storage: The Core Infrastructure for Massive AI Data**

Storage solutions support massive data storage and high-throughput read-write requirements for large-scale models, effectively eliminating storage bandwidth bottlenecks in computing scenarios.

- **Electronics: Stable & Energy-Efficient Support for Intelligent Computing Centers**

Electronics systems provide high-efficiency power supplies, power devices and thermal management solutions for large-scale computing clusters, significantly reducing energy consumption in computing operations.

- **Chips: The Fundamental Ceiling of AI Computing Performance**

GPU, ASIC, SoC, advanced packaging technologies, and semiconductor process materials define the fundamental capabilities of computing hardware.



China International Optoelectronic Exposition (CIOE) – Information and Communication Expo focuses on the core technologies for high-speed data transmission. It showcases high-speed optical modules, LPO/NPO/CPO solutions, high-performance optical chips, OCS all-optical switches, high-speed connectors for computing networking, optical test & measurement equipment, and passive optical components, covering the complete value chain of intelligent computing interconnection.

Featured Exhibitors:

- ✓ **Optical Chips:** COHERENT, MITSUBISHI ELECTRIC, SICOYA, SIFOTONICS, WD PHOTONICS, PHOGRain, QXP, LIObate, EVERBRIGHT, Silux, Xphor, Shijia Photons, ETERN-LASER, CIG...
- ✓ **Optical Module:** HiSilicon, Accelink, HGGenuine, Eoptolink, Ligent, CIG, Luxshare, Linktel, Pioseed, Taclink, O-Net, EverProX, Sont, COHERENT, SOURCE PHOTONICS, Tri-Light...
- ✓ **Optical Fiber Cable:** CORNING, YOFC, hengtong, ZTT, SDG, Fiberhome, Etern, LIGHTERA, WASIN FUJIKURA, SEI Optical Fiber, Inlight, FIBERSIGHT, Youngsun Com...
- ✓ **Switch and Server:** H3C, Ruijie Networks, Fiberhome, Advanced Fiber Resources, Taclink, Visint, BAUD, ISEELINK, Triple-Stone, Glsun, Asterfusion, Fengrunda, Beeplux, Sirivision...

International Integrated Circuit Innovation Expo (IICIE) – As a professional exhibition platform spanning the entire semiconductor industrial chain, IICIE underpins comprehensive fundamental manufacturing processes. Beyond core AI chips, the exhibition features key semiconductor materials, wafer fabrication, packaging & testing equipment, 2.5D/3D advanced packaging, hybrid bonding heterogeneous integrations, and other cutting-edge technologies and products, exploring how advanced packaging technologies overcome the "memory wall" limitations of chips in the AI computing era.

Featured Exhibitors:

- ✓ **Wafer Fabrication and Packaging Service:** HLMC, Nexchip, BYD SEMICONDUCTOR, TONGFU MICROELECTRONICS, MXTronics, BIWIN Storage, Centraway, iA Semiconductor...
- ✓ **Semiconductor Equipment:** NAURA, AMEC, ACM RESEARCH, PIOTECH, Hwatsing, Aspiring, Huayu Semiconductor, Jingce Electronic, CETC, U-PRECISION, SKYVERSE, Maxwell...
- ✓ **Semiconductor Material:** NSIG, Anji Microelectronics, Peric, Shanghai Sinyang, UPERMARSK, XILONG SCIENTIFIC, Chengdu Carbon...

Three Co-Located Exhibitions – Empowering AI Computing



Register Now

Shenzhen International Electronics & Embedded Systems Expo (elexcon) – The exhibition completes the terminal supporting hardware for AI computing clusters. Focusing on high-speed storage modules, high-power managements, power semiconductors, embedded edge AI mainboards, and high-speed interconnection components, the exhibition addresses the high-throughput and high-density power supply demands of ultra-large-scale intelligent computing data centers while delivering comprehensive hardware solutions across complete systems, board card and embedded system.

Featured Exhibitors:

- ✓ **Memory Chip:** Yangtze Memory, Masonsemi, Netac, Dosilicon, Apacer, KEYMOS, Techwinsemi, Yuxin, BOYA, Huaxun, Mindersemi, KingSpec, Chip Star, ADATA Electronics...
- ✓ **Embedded System:** Advantech, SEGGER, Avalue, Puzhi Electronics, ALINX, ALIENTEK, Toradex, Saintway, Linaro...
- ✓ **Power Device and Power Supply:** Belling, AIPULNION, RHM, XLSEMI, Tritech-MOS, Truesemi, JESTEK, POWER WIDE...
- ✓ **Connector:** Soulin, yxcon, Fosen, Chuanghaoxin, SEEPLUS, Plastron, Wanda, Fvwin...

➤ Concurrent Conference:

Date	Conference	Venue	Hall
September 9 th - PM	High-Speed Optical Transmission Technology Innovation in AI Era Forum	9A, 2nd Floor, Hall 9	Hall 9
September 9 th - PM	Optoelectronics Industry Summit – The "Core" Future of Optoelectronics	Conference Room, Hall 13	Hall 13
September 9 th - PM	2026 China MicroLED & CPO Industrial Chain Innovation Development Summit	14B, 2nd Floor, Hall 14	Hall 14
September 9 th - September 10 th	The 8th Embedded Technology Conference China 2026	Conference Room 1, Hall 16	Hall 16
September 9 th	SST Technology Innovation & Industry Development Forum	CC105A, 1 st Floor, Hall 18	Hall 18
September 9 th	AI Data Center Optical-Electrical Integration Innovation Forum: NPO Focus	101B, 1 st Floor, Hall 18	Hall 18
September 9 th - September 10 th	The 10th SiP Conference China 2026	101C, 1 st Floor, Hall 18	Hall 18
September 10 th	Optical Interconnect Technology for AI Computing Clusters Forum	9B, 2nd Floor, Hall 9	Hall 9
September 10 th	Photonics-Electronics Convergence Technology and Industrial Development Forum	9C, 2nd Floor, Hall 9	Hall 9
September 10 th - AM	Photonics at the Core of the AI Vortex: An Overview of the Industry	Conference Room, Hall 13	Hall 13
September 10 th - PM	ePIXfab China-Europe Silicon Photonics Forum	Conference Room, Hall 13	Hall 13
September 10 th	Silicon Photonics Industry Summit in the Era of AI Computing Power	Leadership Summit Area- Conference Room, Hall 14	Hall 14
September 10 th	Advanced packaging & Testing Technology Forum –From CoWoS to CoPoS:Exploration of Advanced Packaging Technology Evolution and Supply Chain Layout for AI Era	14C, 2nd Floor, Hall 14	Hall 14



➤ Empowering Consumer Electronics and AR/VR Innovation & Development

Three co-located exhibitions bring together comprehensive industrial chain resources spanning consumer electronics and AR/VR. The integrated platform showcases seven key technology sectors—**optical imaging & sensing, advanced display, embedded AI, precision connectors, chip & memory, AR/VR product & component, and test & measurement**—providing complete coverage of the entire technical pathway for consumer electronics and AR/VR, spanning spatial perceptions, visual interactions, edge intelligences, high-speed interconnections, computing powers & memory, and performance testing. This comprehensive ecosystem empowers innovation and development across the consumer electronics and AR/VR industries:

- **Optical Imaging & Sensing:** High precision 2D imaging and 3D perception technologies that address critical challenges in image acquisition and spatial interaction recognition
- **Advanced Display:** Low-power, high-definition, flexible, and immersive visual interfaces for advanced human-machine interaction
- **Embedded AI:** Edge-based lightweight computing power enabling real-time intelligent processing and adaptive control
- **Precision Connector:** High-frequency, high-speed miniaturized interconnects designed for compact electronic and electrical architectures
- **Chip & Memory:** High-performance computing cores and high-speed memory solutions supporting demanding workloads and rapid data operations
- **AR/VR Product & Component:** Lightweight near-eye display modules creating immersive mixed-reality interaction experiences
- **Test & Measurement:** Comprehensive performance validation ensuring product calibration and production reliability control

China International Optoelectronic Exposition (CIOE) - Featuring a comprehensive showcase of optical materials and components, optical lenses and modules, 3D visions, LiDAR, spectral sensing, Micro LEDs, silicon-based OLEDs, microdisplays, optical waveguides, AR/VR all-in-one devices, and more.

Featured Exhibitors:

- ✓ **Optical Material and Component:** HOYA, OHARA, SCHOTT, New HuaGuang, Gabrielle-Optech, Lante Optics, Edmund, Crystal-Optech, Grand Unified Optics, Biel Crystal, Yongxin Optics, Nano Macro, Gai Photonics...
- ✓ **Optical Lens and Module:** SUNNY, Phenix Optics, Yutong Optical, AAC Optics, Union Optech, TRACE OPTICAL, Hongjing, Goertek, RICOM, Yongxin Optics, COSTAR, CDGM, NORTH ELECTRO-OPTICS, Lante Optics, Grand Unified Optics, LUXSHARE PRECISION...
- ✓ **3D Vision:** ams OSRAM, visionICs, RaySea, RAYSEES, Zhiqiang Vision, ACTUS, Maxic...

Three Co-Located Exhibitions – Empowering Consumer Electronics & AR/VR



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- ✓ **Spectral Sensing:** CHNSpec, Hyperstecpral Imaging, Spectrum On-chip, Unispectral, DOSPECTRUM, Qiushi Spectrum, spectricon, Magnity, choptics, Wayho, Westlake Intelligent Vision, OptTrace, Spectricity NV, Rudeer, HLT, SPECONE...
 - ✓ **Micro LED & OLED:** Crystal-Optech, VIJO, Sitan Integrated Circuit, LUMICORE, Rayvision, Raysolve, Innovision, SeeYA, BCDTEK, CHIPDISPLAY, Enkris Semiconductor, Stufu...
 - ✓ **Optical Waveguide & AR/VR:** AINSTEK, LUXSHARE, Goertek, Raypai, AAC Optics, Goowave, ELEPN Projection, North Ocean, Xvisio Technology, InsEye, Raontech, Hongshi Intelligent, MyRias, Illusion, Gravity, conant, TIMEMAKER, Moldnano, Tobii...
 - ✓ **Optical Testing & Measurement:** Keyence, CARL ZEISS, TAYLOR HOBSON, ZYGO, Bruker, Panasonic, TRIOPTICS, Mitutoyo, Hexagon, Chotest, ATOMETRICS, ideaoptics, DZOPTICS, MARPOSS, interfero, ToupTek, AcroBeam, MOTIC, SHUMIN, OTO PHOTONICS...
-

International Integrated Circuit Innovation Expo (IICIE) - Bringing together consumer-grade chip and fabless, featuring a comprehensive showcase of core integrated circuit products including AI computing chips, main controller SoCs, Bluetooth BLE RF chips, PMICs, and application-specific AI processors.

Featured Exhibitors:

INGENIC, Zhaoxin Semiconductor, Montage Technology, Emphyrean, Semitronix, AXS Technology, Hercules Microelectronics, Geehy Semiconductor, Starry Stone Tech, Yangtze Mason Semiconductor, Brite Semiconductor, Binarysemi...

Shenzhen International Electronics & Embedded Systems Expo (elexcon) – Deeply focused on the electronics hardware and systems, covering the full spectrum of electronic components, memory chips and modules, power semiconductors, power solutions, edge-embedded AI, connectors, and other foundational hardware, completing the underlying supply chain for end-user products.

Featured Exhibitors:

- ✓ **Chip and Module:** HDSC, GZLG, MindMotion, Codefairsemi, Suo Micro, Lingyange, FDMTEK, Waytronic, NineChip...
- ✓ **Embedded:** Advantech, SEGGER, Avalue, Puzhi Electronics, ALINX, ALIENTEK, Toradex, Saintway, Linaro...
- ✓ **Electronics Component:** Jingquanhua, UNI ROYAL, Weirong, EYANG, Shenzhen Huaqiang, YXC, Sunway Communication, Dehong induction, SUSUMU, XTY, Hretech, FOSAN, Aoyuda, HUASUN, YJYCOIN, Houwei Electronics, Junkang Electronics, Cstec...
- ✓ **Power Supply:** Jingquanhua, Belling, AIPULNION, RHM, XLSEMI, Tritech-MOS, Truesemi, JESTEK, POWER WIDE...
- ✓ **Connector:** Soulin, yxcon, Fosen, Chuanghaoxin, SEEPLUS, Plastron, Wanda, Fwwin...

Three Co-Located Exhibitions – Empowering Consumer Electronics & AR/VR



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➤ **Concurrent Conference:**

Date	Conference	Venue	Hall
September 9 th - PM	Global Spatial Computing Industry Forum	Conference Room, Hall 2	Hall 2
September 9 th - PM	AR/VR Optical Technology Application Summit Forum	2B, 2nd Floor, Hall 2	Hall 2
September 9 th - PM	2026 Smart Home Development Trends Forum	6A, 2nd Floor, Hall 6	Hall 6
September 9 th - PM	2026 RISC-V Industry Ecosystem Conference	14C, 2nd Floor, Hall 14	Hall 14
September 9 th - PM	3rd AI-Enabled Consumer Electronics Innovation Forum	Conference Room, Hall 14	Hall 14
September 9 th - September 10 th	The 8th Embedded Technology Conference China 2026	Conference Room 1, Hall 16	Hall 16
September 10 th - AM	Edge AI Chip Power: 2026 Smart Terminal Chip Ecosystem Summit	Conference Room, Hall 14	Hall 14
September 10 th	Global Microdisplay Industry Development Forum	Conference Room, Hall 2	Hall 2
September 10 th	AI AR Glasses Industry Development Forum	2C, 2nd Floor, Hall 2	Hall 2
September 10 th - PM	Handheld Intelligent Imaging Device Technology Development Forum	Conference Room, Hall 3	Hall 3
September 10 th - PM	Source of Intelligent Computing: 2026 Chip Computing Power Innovation Summit	Conference Room, Hall 14	Hall 14
September 11 th - AM	Large-Scale Interaction and Immersive Experience Technology Summit	Conference Room, Hall 2	Hall 2
September 11 th - AM	Optoelectronics-Driven New Quality Productive Forces in Low-Altitude Economy Forum	Conference Room, Hall 7	Hall 7

Featured Zones:

- ✓ XR Glasses Teardown Zone – Hall 2
- ✓ Telescope and Astronomical Equipment Zone – Hall 3
- ✓ RISC-V Ecosystem + Application Zone – Hall 14
- ✓ AI + Application Zone – Hall 14

Three Co-Located Exhibitions – Empowering Automotive Electronics and Embodied Robot



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Empowering Automotive Electronics and Embodied Robot Industries

Three co-located exhibitions bring together the entire intelligent automotive industry chain, offering a comprehensive showcase of automotive optical communications, multi-sensor fusion solutions, automotive displays, automotive three-electric systems (battery, motor, and electronic control), and automotive wiring harnesses. Five key technology segments provide full coverage of the intelligent automotive technology chain - from perception and high-speed transmission to power supply, automotive wiring, and cockpit interaction:

- **Automotive Optical Communication:** Delivering up to 100 Gbps lossless data transmission to address the high-bandwidth challenges of advanced autonomous driving.
- **Multi-Sensor Fusion:** Enabling all-weather, round-the-clock precision environmental perception while eliminating blind spots inherent to single-sensor systems.
- **Automotive Display:** Creating immersive human-vehicle interaction experiences within the cockpit.
- **Three-Electric Systems:** Providing stable, reliable power to support EV range, fast charging, and the operation of all onboard intelligent hardware.
- **Lightweight, High-Shielding Wiring Harnesses:** Optimized for next-generation centralized electronic and electrical architectures.

China International Optoelectronic Exposition (CIOE) - Automotive Highlights: The exhibition covers three major automotive-related sectors including automotive optical communication, automotive perception, and automotive display. Featured products include optical chips, optical modules, automotive-grade optical fiber harnesses, automotive cameras, in-vehicle infrared night vision systems, 3D vision perception solutions, LiDAR, smart cockpit displays, and Mini/Micro LED, among others.

Featured Exhibitors:

- ✓ **Automotive Cameras:** SUNNY, Union Optech, Yutong Optical, Phenix Optics, AAC Optics, TRACE OPTICAL, FOCTek, COSTAR, Hitronics...
- ✓ **3D Vision:** ams OSRAM, visionICs, RaySea, RAYSEES, Zhiqiang Vision, Maxic, ToFFuture, SLAMTEC, Lucidus, Litra, SMITSense, Lanhai Photoelectricity...
- ✓ **Infrared Night Vision:** Guide Infrared, Raytron, DALI TECHNOLOGY, FJR, NORTH NIGHT-VISION, HIKMICRO, Pixfra, Kunteng Photonics, Huaguo Optical, Vital Optics...
- ✓ **Automotive Display:** Crystal-Optech, Saphlux, SMARTVISION, Sitan Integrated Circuit, LEKIN, Raysolve, SeeYA, LUMICORE, Westlake Smoky Mountains, BCDTEK, Innovision...
- ✓ **Chip & Module:** COHERENT, Poncan, Accelink, PHOGRain, Dogain, Dapu Telecom, MITSUBISHI, Sanan Optoelectronics, EVERBRIGHT, QXP, Guangte, CETC, Silux, San-U, Diao Microcircuits, UX IC, Minisilicon, SUNA, Litorex, EOCHIP, Ferrotec, Glostar, Beogold, Shengda, Advanced Thermoelectric...
- ✓ **In-Vehicle Network:** YOFC, Fiberhome, Kepteck, HGGENUINE, CORNING, OE Photonics, LTK Electric Wire, Etern, Huasheng Futao...

Three Co-Located Exhibitions – Empowering Automotive Electronics and Embodied Robot



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International Integrated Circuit Innovation Expo (IICIE) - Bringing together chip and IC design manufacturers, IICIE covers MCUs, SoCs, motion control chips, and security encryption chips, alongside automotive-grade wafer manufacturing and high-reliability packaging. A dedicated **AI + Automotive Electronics Application Zone** will feature leading companies from the chip and solution provider ecosystem.

Featured Exhibitors:

INGENIC, Zhaoxin Semiconductor, Montage Technology, Emipyrean, Semitronix, AXS Technology, Hercules Microelectronics, Geehy Semiconductor, Starry Stone Tech, Yangtze Mason Semiconductor, Brite Semiconductor, Binarysemi...

Shenzhen International Electronics & Embedded Systems Expo (elexcon) - Covering automotive-grade and robotics hardware solutions, elexcon features automotive-grade passive components, in-vehicle power management ICs, servo drive power devices, robotic embedded motion control boards, industrial-grade high-speed connectors, wide-temperature storage modules, and edge real-time control systems. The exhibition delivers comprehensive hardware solutions for automotive electronic control and robot system integration.

Featured Exhibitors:

Advantech, Yangtze Memory, SEGGER, HDSC, MindMotion, Belling, Netac, Dosilicon, Techwinsemi, Apacer, Sunway Communication, Weirong, Jingquanhua, EYANG, UNI ROYAL, GZLG, Avalue, NineChip...

➤ Concurrent Conference:

Date	Conference	Venue	Hall
September 9 th - PM	The 5 th Automotive Camera Technology and Testing Forum	1B, 2nd Floor, Hall 1	Hall 1
September 9 th - PM	2026 RISC-V Industry Ecosystem Conference	14C, 2nd Floor, Hall 14	Hall 14
September 9 th - September 10 th	The 8th Embedded Technology Conference China 2026	Conference Room 1, Hall 16	Hall 16
September 9 th	New Energy Vehicle Electronics Innovation Forum	CC105B, 1st Floor, Hall 18	Hall 18
September 10 th	The 8 th Intelligent Vehicle Technology Forum	5C, 2nd Floor, Hall 5	Hall 5
September 10 th	The 41 st MEMS Seminar: 3D Sensing and Imaging Technology Application	6B, 2nd Floor, Hall 6	Hall 6
September 10 th	Automotive Optical Communication Technology Innovation and Application Forum	9A, 2nd Floor, Hall 9	Hall 9
September 10 th	Automotive Chip Industry Innovation Forum	14B, 2nd Floor, Hall 14	Hall 14

Featured Zones:

- ✓ Automotive Display Zone - Hall 2
- ✓ Automotive Optical Communication Live Demonstration Pavilion - Hall 13
- ✓ Automotive Chip Zone - Hall 14
- ✓ AI+ Automotive Electronics Application Zone - Hall 14



➤ Empowering the Embodied Robot Industry

Three co-located exhibitions unite to present a comprehensive suite of core hardware and software solutions: vision perception modules enable object recognition, human-robot interaction, and close-range environmental detection; power devices manage power conversion and servo motor control, directly determining robotic motion performance, endurance, and overall weight efficiency; connectors and wiring harnesses simultaneously support dual-channel transmission for both power delivery and high-speed data; and the full-stack chip portfolio builds the complete computing architecture for the robot – serving as the "decision-making brain, motion control cerebellum, and sensory neural network."

Featured Zones:

- ✓ A dedicated **Embodied Robot Zone** will be located in Hall 6 of CIOE, bringing together leading industry players including AUBO, GALAXYCORE, GENISOM AI, HASCO, LANHAI PHOTOELECTRICITY, RISONG, and more.

➤ Concurrent Conference:

Date	Conference	Venue	Hall
September 9 th - PM	2026 Embodied Intelligence Industry Conference – From Computing Power to Execution, Building Embodied Intelligence Systems	Conference Room, Hall 15	Hall 15
September 9 th - September 10 th	The 8th Embedded Technology Conference China 2026	Conference Room 1, Hall 16	Hall 16
September 10 th - AM	Smart Optics for Embodied AI Forum	1A, 2nd Floor, Hall 1	Hall 1
September 10 th	Embodied Intelligent Robots Integrated Application Forum	6A, 2nd Floor, Hall 6	Hall 6



➤ Empowering Semiconductor & Intelligent Manufacturing Upgrades

Three co-located exhibitions bring together the complete intelligent manufacturing value chain, offering a comprehensive showcase of semiconductor materials, semiconductor equipment, semiconductor manufacturing and packaging services, precision optical processing, lasers and laser equipment, industrial embedded systems, core parts, and test & measurement. The platform comprehensively covers the full spectrum of semiconductor and intelligent manufacturing – from semiconductor manufacturing, packaging & testing, precision optical processing, vision inspection, to laser manufacturing – enabling enhanced quality, efficiency, and flexible, intelligent upgrades.

- **Semiconductor Material:** Provide the foundation for chip manufacturing, supporting wafer processing, chip interconnection, and advanced packaging.
- **Semiconductor Equipment:** Wafer fabrication and packaging & testing equipment, securing the supply base of core chips for advanced applications.
- **Wafer Fabrication, Packaging & Testing Service:** Covering wafer fabrication and advanced packaging processes, enabling chip process iteration and scaled mass production.
- **Test & Measurement:** Full-spectrum inspection, calibration, and metrology to ensure equipment accuracy and robust production quality control.
- **Industrial Vision:** High-precision machine vision for in-line inspection, positioning, and measurement on production lines.
- **Precision Optical Manufacturing:** Micro- and nano-level, high-precision machining to meet the complex shaping requirements of precision components.
- **Lasers & Laser Processing & Manufacturing:** High-energy laser processes enabling cutting, welding, marking and surface treatment.
- **Industrial Embedded System:** High-reliability edge computing power, supporting production line computation and equipment coordination.
- **Core Parts & System:** High-end functional modules ensuring long-term, stable operation of intelligent equipment.

China International Optoelectronic Exposition (CIOE) – It will showcase high precision industrial lenses, industrial sensors, 2D/3D machine vision cameras, lasers and laser system for marking, cutting, and welding, spectral inspection instrument, infrared measurement devices, optical coating equipment, optical systems, and more - all used in precision manufacturing for defect inspection, dimensional metrology, and automated positioning.

Featured Exhibitors:

- ✓ **Wafer Fabrication & Packaging & Testing Equipment:** GlobalFoundries, Tower Semiconductor, United Nova, CUMEC, PIC, ASTRO PLASMA, ASMPT, JEOL, Raith, E-Globaledge, Samco, Navikey Semiconductor, ALL-SEMI MICRO, SEMC, Therlicon, Yantai Huachuang, Finetech, MRSI, MKS, OXFORD INSTRUMENTS, iN-Cube, Colibri, Mingseal Robot, GKG, QUICK, Qting, Superwave, Opto-Intel, MPI, UIGreen, SEMISHARE, PI, ORIENTAL MOTOR, ACS Motion Control...

Three Co-Located Exhibitions – Empowering Semiconductor & Intelligent Manufacturing



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Featured Exhibitors:

- ✓ **Lasers & Laser Processing:** IPG, Raycus, Han's Tiancheng Semiconductor, EVERBRIGHT, Maxphotonics, Light Conversion, Litilit, Luxinar Laser, GLORY PHOTONICS, Crystrong, GONGDA LASER, INNO LASER, ZOLIX, Inngu Laser, HGGENUINE, HYMSON LASER, INTE LASER, LASERVALL, ANEWBEST, Vi Laser, CKD, Newlaz, Zmotion, QIGO, FEELTEK...
- ✓ **Intelligent Equipment & Industrial Automation:** HGGENUINE, CFMEE, Misumi, TOYO AUTOMATION, SIMAX, Kurtz Ersas, GOANWIN, TGB Precision, MOJI-NANO, FREEGES, MAXAIR, Arison, MUSASHI, Shinwa, Flexem, KAIFULL, Aihefa, YESSYS, MultiFields, Jetran...
- ✓ **Precision Optical Processing:** AMETEK Precitech, DKSH, Satisloh, Cranfield Precision, Nextas, Bozhongtaida, Huacui, GermanLitho, Shibaura Machine, Schneider Electric, DKSH, Shangneng Precision, Damin Chandon, Langxin Optics, XIBIN, Hengtai, Genertec...
- ✓ **Optical Coating Equipment:** Bühler Leybold, OPTORUN, IBD, HuiCheng Vacuum, HANA, AVP, IZOVAC, SHINCRON, Youlun Vacuum, Gilitek, Sinoprime, SHOWA SHINKU, HANA, Keymang, Pilot, Tianyi Guotai, Soleras, Nanofilm Vacuum, SINO MULTI-MICRO, Longway...
- ✓ **Infrared Testing & Measurement:** Thorlabs, Optris, Golden Way, Zhenxing, HGH, UTOP-SINO, B&W TEK, IES, Yingda Hi-Tech, I-TEC, HGH, B&W TEK, Super Source, IntelliMeasure...
- ✓ **Industrial Sensor:** Micro-Epsilon, Stella, ODTECH, Hamamatsu, BRIGATES, Light-Catcher, WING CHIP, siman sensor, Haomo, Ysensor, Inxun, Beephton, LECHENG, KODENSHI, Atto Motion, Time Vision...

International Integrated Circuit Innovation Expo (IICIE) – The exhibition will feature a dedicated showcase of core parts including precision machinery and structural components, flow/pressure control systems, RF/power modules, motion control systems, machine visions, sensors, and more. Bringing leading semiconductor equipment manufacturers together under one roof, the expo serves as a launchpad for automation equipment suppliers to move into the high-end segment. Through on-site demonstrations of advanced semiconductor equipment and precision production lines, complemented by targeted technical matchmaking, manufacturers will gain first-hand insight into the industry's stringent standards and evolving requirements. This exposure enables them to rapidly close gaps in technology, process capability, and application deployment, accelerating efficient entry into the high-end semiconductor equipment market.

Featured Exhibitors:

- ✓ **Semiconductor Material:** NSIG, Anji Microelectronics, Peric, Shanghai Sinyang, UPERMARSK, XILONG SCIENTIFIC, Chengdu Carbon...
- ✓ **Semiconductor Equipment:** NAURA, AMEC, ACM RESEARCH, PIOTECH, Heyan Technology, Hwatsing, Aspiring, Huayu Semiconductor, Longyoude, Jingce Electronic, CETC, U-PRECISION, SKYVERSE, Maxwell, DJEL, VEGA TECHNOLOGY, Mitutoyo, R.D.S, Winmax...
- ✓ **Wafer Fabrication, Packaging & Testing Service:** HLME, Nexchip, BYD SEMICONDUCTOR, TONGFU MICROELECTRONICS, MXTronics, NCAP China, BIWIN Storage Technology, Centraway, iA Semiconductor...
- ✓ **Semiconductor Core Parts & Intelligent Manufacturing Solution:** SKY, SSME, Vacree, HIWIN, KL Group, Canrill, SPECK, KEYENCE, GY-Technology, Omat, STARCHAIN, XINGQI...

Three Co-Located Exhibitions – Empowering Semiconductor & Intelligent Manufacturing



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Shenzhen International Electronics & Embedded Expo (elexcon 2026) – The show builds the hardware foundation for intelligent manufacturing, presenting a comprehensive lineup of industrial embedded motherboards, PLC core controllers, servo-drive power supplies, industrial-grade components, high-reliability connectors, wide-temperature storages, and industrial IoT gateways. The expo highlights standardized production-line control and edge-computing solutions that scale across automation lines in 3C, semiconductor, and new-energy sectors.

Featured Exhibitors:

Advantech, Avalue, SEGGER, ALIENTEK, Toradex, ZLG, SEGGER, ALINX, Puzhi Electronics, Saintway, Jingquanhua...

➤ Concurrent Conference:

Date	Conference	Venue	Hall
September 11 th - AM	Advanced Optics and Intelligent Sensing Technology Forum	1C, 2nd Floor, Hall 1	Hall 1
September 9 th - PM	Laser Micro and Nano Processing Advanced Manufacturing Forum	2C, 2nd Floor, Hall 2	Hall 2
September 9 th - PM	Laser Technology Empowering Semiconductor Industry Manufacturing Forum	2A, 2nd Floor, Hall 2	Hall 2
September 9 th - PM	Laser Welding for Smart Manufacturing Innovation Application Forum	Conference Room, Hall 4	Hall 4
September 9 th - PM	Optical Semiconductor Inspection Technology Forum	5B, 2nd Floor, Hall 5	Hall 5
September 9 th - PM	Nanoimprint Manufacturing Technology Forum	5C, 2nd Floor, Hall 5	Hall 5
September 9 th - PM	Advanced Material Innovation Forum—Breaking Through the Limits - Key Materials for AI Heterogeneous Integration Packaging	13A, 2nd Floor, Hall 13	Hall 13
September 9 th - PM	2026 Intelligent Manufacturing Innovation and Development Conference	14A, 2nd Floor, Hall 14	Hall 14
September 9 th - PM	Core Semiconductor Manufacturing Equipment and Components Development Forum	Conference Room, Hall 16	Hall 16
September 9 th - September 10 th	The 8th Embedded Technology Conference China 2026	Conference Room 1, Hall 16	Hall 16
September 10 th	IWAPS International Workshop on Advanced Patterning Solutions	Mangrove A, Second Floor, South Lobby	South Lobby
September 10 th - AM	Meta-optical & Micro-nano Optical Manufacturing Technology Forum	5A, 2nd Floor, Hall 5	Hall 5
September 10 th - PM	Optical Ultra-precision Manufacturing Forum	5A, 2nd Floor, Hall 5	Hall 5
September 10 th	Optics Vacuum Coating Forum	Conference Room, Hall 7	Hall 7
September 10 th	Advanced packaging & Testing Technology Forum —From CoWoS to CoPoS: Exploration of Advanced Packaging Technology Evolution and Supply Chain Layout for AI Era	14C, 2nd Floor, Hall 14	Hall 14
September 10 th	Intelligent Industrial Control Empowering Automation Innovation Forum	Conference Room, Hall 15	Hall 15
September 10 th	Compound Semiconductor Advanced Packaging & SiC Embedded PCB Supply Chain Forum	Conference Room, Hall 16	Hall 16
September 11 th	IWAPS International Workshop on Advanced Patterning Solutions	5AB, 2nd Floor, Hall 5; 6AB, 2nd Floor, Hall 6; 9AB, 2nd Floor, Hall 9;	Hall 5 Hall 6 Hall 9
September 11 th - AM	2nd Edge AI and Intelligent Control Technology Industry Forum	Conference Room, Hall 15	Hall 15
September 11 th - AM	Semiconductor Clean Utility & Energy Management Forum	Conference Room, Hall 16	Hall 16

Featured Zones:

- ✓ Laser Welding Zone - Hall 2
- ✓ Sapphire Processing & Application Zone - Hall 3
- ✓ Optical Injection Molding / Molded Aspheric Zone - Hall 3



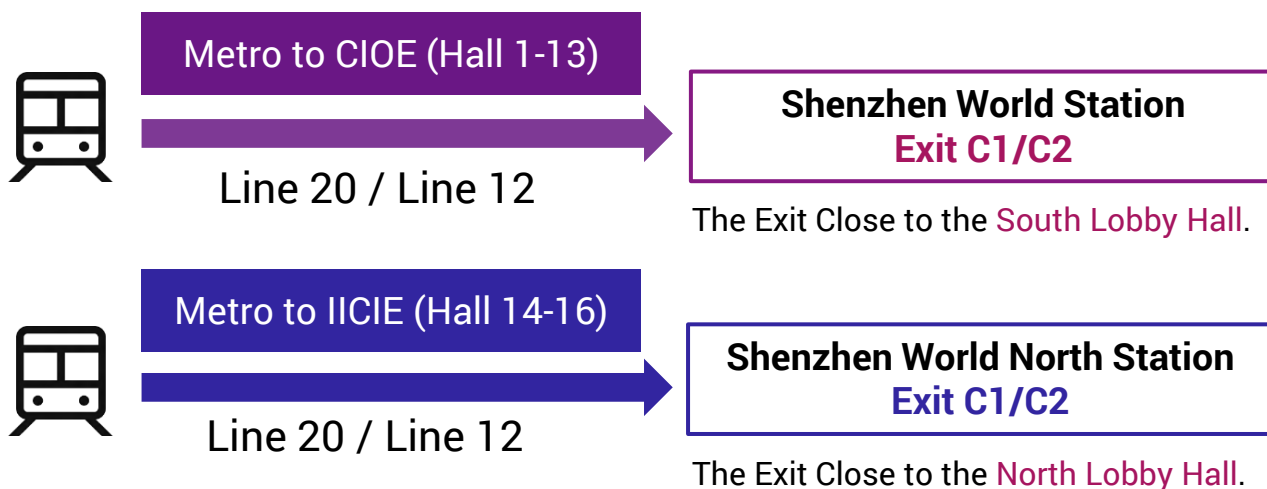
Traffic Guide (For more: <https://www.cioe.cn/en/Traffic.html>)

Shenzhen World Exhibition & Convention Center

Address: No.1 Zhancheng Road, Fuhai Street, Bao'an District, Shenzhen, Guangdong, China

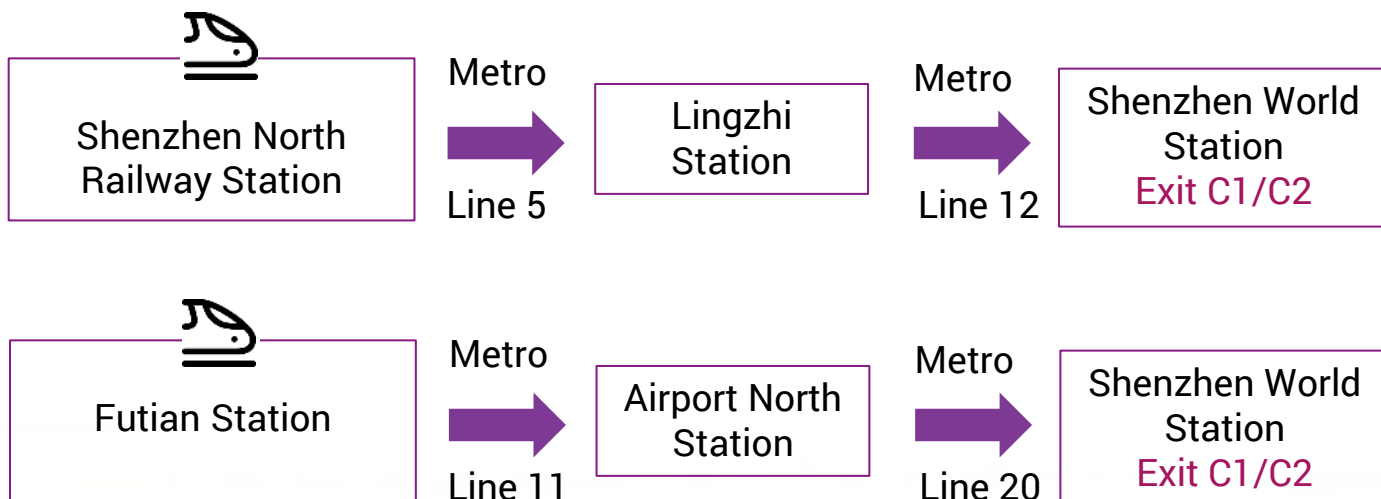
Chinese Address: 广东省深圳市宝安区福海街道展城路1号

➤ Metro Direct to Exhibition Hall



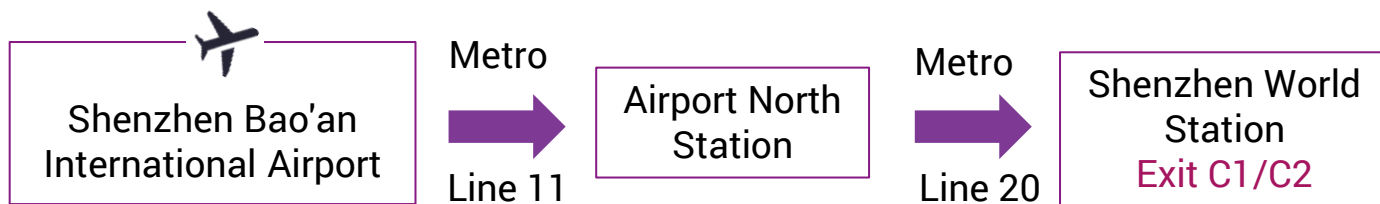
More on Shenzhen Metro Website

➤ Highspeed Train Station (Shenzhen North Railway Station or Futian Station)

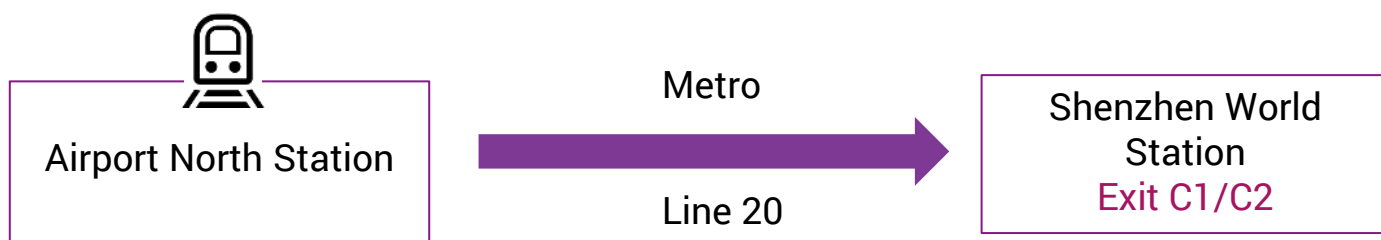




➤ Airport



➤ Intercity Railway (Airport North Station)



➤ From Hong Kong to Shenzhen

From Hong Kong China Ferry Terminal (中港城码头)

Take the ferry to Shenzhen Airport Ferry Terminal, and take a taxi directly to the venue.

From Hong Kong International Airport (75 km to the venue)

By Cross-Border Bus: Direct coach services to Shenzhen, then taxi or metro to the venue.

By Ferry: SkyPier (海天客运码头) → Shekou Ferry Terminal (蛇口码头)

Then transfer to taxi or Metro Line 12 to reach the venue.

From Hong Kong West Kowloon Station (西九龙站)

Take high-speed rail to Futian Station (福田站) → Take Metro Line 11 to Airport North Station (机场北站) → Transfer to Line 20 to Shenzhen World Station (国展站) → Exit C1/C2

From Hong Kong Border Crossings

From Futian, Huanggang, Luohu, and other border checkpoints, you can directly transfer to Shenzhen Metro after clearing customs to reach the venue.

**IICIE**INTERNATIONAL
INTEGRATED CIRCUIT
INNOVATION EXPO

IICIE 2026

INTERNATIONAL INTEGRATED CIRCUIT INNOVATION EXPO

**September 9-11, 2026****Shenzhen World**
Exhibition & Convention Center**CHINA****50,000**^{m²} Exhibition Area**60,000**⁺ Visitors**1,100**⁺ Exhibitors

Connect with Industry Leaders

Chip and IC Design

INGENIC, Zhaoxin Semiconductor, Montage Technology, Emphyrean, Semitronix, AXS Technology, Sevenstar, Hercules Microelectronics, Geehy Semiconductor, Starry Stone Tech, Yangtze Mason Semiconductor, Brite Semiconductor, Binarysemi...

Manufacturing / Packaging and Testing

HLMC, Nexchip, BYD SEMICONDUCTOR, TONGFU MICROELECTRONICS, MXTronics, NCAP China, BIWIN Storage Technology, Centraway, iA Semiconductor...

Semiconductor Equipment

NAURA, AMEC, ACM RESEARCH, PIOTECH, Heyan Technology, Hwatsing, Aspiring, Huayu Semiconductor, Longyoude, Jingce Electronic, CETC, U-PRECISION, SKYVERSE, Maxwell, DJEL, VEGA TECHNOLOGY, Mitutoyo, R.D.S, Winmax...

Semiconductor Material

NSIG, Anji Microelectronics, Peric, Shanghai Sinyang, UPERMARSK, XILONG SCIENTIFIC, Chengdu Carbon...

Semiconductor Core Parts

SKY, SSME, Vacree, HIWIN, KL Group, Canrill, SPECK, KEYENCE, GY-Technology, Omat, STARCHAIN, XINGQI...

*Partial exhibitor list in no particular order and is subject to change.

**One Pass for
Three Exhibitions****Official WhatsApp**

The 23rd Shenzhen International Electronics & Embedded Expo

elexcon 2026

All for **AI**, All for **GREEN**

September 9-11, 2026

Shenzhen World Exhibition & Convention Center (Bao'an)

Co-located with:



CHINA INTERNATIONAL
OPTOELECTRONIC EXPO



IICIE
INTERNATIONAL
INTEGRATED CIRCUIT
INNOVATION EXPO

320,000m²

Mega Scale

240,000⁺

Visitors

5,000⁺

Exhibitors

Three Co-located Exhibitions

Building a New Ecosystem for Electronics, Embedded Systems & Photonics



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Embedded Systems | Edge AI

Power Devices & Power Supplies | Passive Components

SiP & Advanced Packaging |

High-Speed Connectivity & Connectors



WELCOME TO CIOE 2026

THE 27th CHINA INTERNATIONAL OPTOELECTRONIC EXPOSITION

SEPTEMBER 9 – 11, 2026
SHENZHEN, CHINA

SHENZHEN WORLD EXHIBITION & CONVENTION CENTER



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Co-located Events



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